FLEX 8000

## Features...

Low-cost, high-density, register-rich CMOS programmable logic
device (PLD) family (see Table 1)

- 2,500 to 16,000 usable gates
- 282 to 1,500 registers
- System-level features
- In-circuit reconfigurability (ICR) via external Configuration EPROM or intelligent controller
- Fully compliant with the peripheral component interconnect (PCI) standard
- Built-in Joint-Test Action Group (JTAG) boundary-scan test (BST) circuitry compliant with IEEE Std. 1149.1-1990 on selected devices
- MultiVolt ${ }^{\mathrm{TM}} \mathrm{I} / \mathrm{O}$ interface enabling device core to run at 5.0 V , while I/O pins are compatible with $5.0-\mathrm{V}$ and $3.3-\mathrm{V}$ logic levels
- Low power consumption (typical specification less than 0.5 mA in standby mode)
Flexible interconnect
- FastTrack ${ }^{\text {TM }}$ Interconnect continuous routing structure for fast, predictable interconnect delays
- Dedicated carry chain that implements arithmetic functions such as fast adders, counters, and comparators (automatically used by software tools and megafunctions)
- Dedicated cascade chain that implements high-speed, high-fan-in logic functions (automatically used by software tools and megafunctions)
- Tri-state emulation that implements internal tri-state nets
- Powerful I/O pins
- Programmable output slew-rate control reduces switching noise

Peripheral register for fast setup and clock-to-output delay
Table 1. FLEX 8000 Device Features

| Feature | EPF8282A <br> EPF8282AV | EPF8452A | EPF8636A | EPF8820A | EPF81188A | EPF81500A |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Usable gates | 2,500 | 4,000 | 6,000 | 8,000 | 12,000 | 16,000 |
| Flipflops | 282 | 452 | 636 | 820 | 1,188 | 1,500 |
| Logic array blocks (LABs) | 26 | 42 | 63 | 84 | 126 | 162 |
| Logic elements (LEs) | 208 | 336 | 504 | 672 | 1,008 | 1,296 |
| Maximum user I/O pins | 78 | 120 | 136 | 152 | 184 | 208 |
| JTAG BST circuitry | Yes | No | Yes | Yes | No | Yes |

...and More
Features

- Fabricated on an advanced SRAM process
- Available in a variety of packages with 84 to 304 pins (see Table 2)
- Software design support and automatic place-and-route provided by the Altera ${ }^{\circledR} \mathrm{MAX}+\mathrm{PLUS}{ }^{\circledR}$ II development system for 486- and Pentium-based PCs, and Sun SPARCstation, HP 9000 Series 700/800, and IBM RISC System/ 6000 workstations
- Additional design entry and simulation support provided by EDIF 200 and 300 netlist files, library of parameterized modules (LPM), Verilog HDL, VHDL, and other interfaces to popular EDA tools from manufacturers such as Cadence, Exemplar Logic, Mentor Graphics, OrCAD, Synopsys, Synplicity, and Veribest

Table 2. FLEX 8000 Package Options \& I/O Pin Count Note (1)

| Device | 84-Pin <br> PLCC | 100- <br> Pin <br> TQFP | 144- <br> Pin <br> TQFP | 160- <br> Pin <br> PQFP | 160- <br> Pin <br> PGA | 192- <br> Pin <br> PGA | 208- <br> Pin <br> PQFP | 225- <br> Pin <br> BGA | 232- <br> Pin <br> PGA | 240- <br> Pin <br> PQFP | 280- <br> Pin <br> PGA | 304- <br> Pin <br> RQFP |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| EPF8282A | 68 | 78 |  |  |  |  |  |  |  |  |  |  |
| EPF8282AV |  | 78 |  |  |  |  |  |  |  |  |  |  |
| EPF8452A | 68 | 68 |  | 120 | 120 |  |  |  |  |  |  |  |
| EPF8636A | 68 |  |  | 118 |  | 136 | 136 |  |  |  |  |  |
| EPF8820A |  |  | 112 | 120 |  | 152 | 152 | 152 |  |  |  |  |
| EPF81188A |  |  |  |  |  | 148 |  | 184 | 184 |  |  |  |
| EPF81500A |  |  |  |  |  |  |  |  |  | 181 | 208 | 208 |

Note:
(1) FLEX 8000 device package types include plastic J-lead chip carrier (PLCC), thin quad flat pack (TQFP), plastic quad flat pack (PQFP), power quad flat pack (RQFP), ball-grid array (BGA), and pin-grid array (PGA) packages.

Altera's Flexible Logic Element MatriX (FLEX ${ }^{\circledR}$ ) family combines the benefits of both erasable programmable logic devices (EPLDs) and fieldprogrammable gate arrays (FPGAs). The FLEX 8000 device family is ideal for a variety of applications because it combines the fine-grained architecture and high register count characteristics of FPGAs with the high speed and predictable interconnect delays of EPLDs. Logic is implemented in LEs that include compact 4-input look-up tables (LUTs) and programmable registers. High performance is provided by a fast, continuous network of routing resources.

FLEX 8000 devices provide a large number of storage elements for applications such as digital signal processing (DSP), wide-data-path manipulation, and data transformation. These devices are an excellent choice for bus interfaces, TTL integration, coprocessor functions, and high-speed controllers. The high-pin-count packages can integrate multiple 32-bit buses into a single device. Table 3 shows FLEX 8000 performance and LE requirements for typical applications.

Table 3. FLEX 8000 Performance

| Application | LEs Used | A-2 Speed Grade | A-3 Speed Grade | A-4 Speed <br> Grade | Units |
| :--- | :---: | :---: | :---: | :---: | :---: |
| 16-bit loadable counter | 16 | 125 | 95 | 83 | MHz |
| 16-bit up/down counter | 16 | 125 | 95 | 83 | MHz |
| 24-bit accumulator | 24 | 87 | 67 | 58 | MHz |
| 16-bit address decode | 4 | 4.2 | 4.9 | 6.3 | ns |
| 16-to-1 multiplexer | 10 | 6.6 | 7.9 | 9.5 | ns |

All FLEX 8000 device packages provide four dedicated inputs for synchronous control signals with large fan-outs. Each I/O pin has an associated register on the periphery of the device. As outputs, these registers provide fast clock-to-output times; as inputs, they offer quick setup times.

The logic and interconnections in the FLEX 8000 architecture are configured with CMOS SRAM elements. FLEX 8000 devices are configured at system power-up with data stored in an industry-standard parallel EPROM or an Altera serial Configuration EPROM device, or with data provided by a system controller. Altera offers the EPC1, EPC1213, EPC1064, and EPC1441 Configuration EPROMs, which configure FLEX 8000 devices via a serial data stream. Configuration data can also be stored in an industry-standard $32 \mathrm{~K} \times 8$ bit or larger EPROM, or downloaded from system RAM. After a FLEX 8000 device has been configured, it can be reconfigured in-circuit by resetting the device and loading new data. Because reconfiguration requires less than 100 ms , realtime changes can be made during system operation.

For information on how to configure FLEX 8000 devices, go to the following documents:

[^0]FLEX 8000 devices contain an optimized microprocessor interface that permits the microprocessor to configure FLEX 8000 devices serially, in parallel, synchronously, or asynchronously. The interface also enables the microprocessor to treat a FLEX 8000 device as memory and configure the device by writing to a virtual memory location, making it very easy for the designer to create configuration software.

The FLEX 8000 family is supported by Altera's MAX+PLUS II development system, a single, integrated package that offers schematic, text-including the Altera Hardware Description Language (AHDL), VHDL, and Verilog HDL—and waveform design entry; compilation and logic synthesis; simulation and timing analysis; and device programming. The MAX+PLUS II software provides EDIF 200 and 300 , library of parameterized modules (LPM), VHDL, Verilog HDL, and other interfaces for additional design entry and simulation support from other industrystandard PC- and UNIX workstation-based EDA tools. The MAX+PLUS II software runs on 486- and Pentium-based PCs, and Sun SPARCstation, HP 9000 Series 700/800, and IBM RISC System/6000 workstations.

The MAX + PLUS II software interfaces easily with common gate array EDA tools for synthesis and simulation. For example, the MAX + PLUS II software can generate Verilog HDL files for simulation with tools such as Cadence Verilog-XL. Additionally, the MAX+PLUS II software contains EDA libraries that use device-specific features such as carry chains, which are used for fast counter and arithmetic functions. For instance, the Synopsys Design Compiler library supplied with the MAX+PLUS II development system includes DesignWare functions that are optimized for the FLEX 8000 architecture.

## Functional Description

For more information on the MAX+PLUS II software, go to the MAX + PLUS II Programmable Logic Development System $\mathcal{E}$ Software Data Sheet in this data book.

The FLEX 8000 architecture incorporates a large matrix of compact building blocks called logic elements (LEs). Each LE contains a 4-input LUT that provides combinatorial logic capability and a programmable register that offers sequential logic capability. The fine-grained structure of the LE provides highly efficient logic implementation.

Eight LEs are grouped together to form a logic array block (LAB). Each FLEX 8000 LAB is an independent structure with common inputs, interconnections, and control signals. The LAB architecture provides a coarse-grained structure for high device performance and easy routing.

Figure 1 shows a block diagram of the FLEX 8000 architecture. Each group of eight LEs is combined into an LAB; LABs are arranged into rows and columns. The I/O pins are supported by I/O elements (IOEs) located at the ends of rows and columns. Each IOE contains a bidirectional I/O buffer and a flipflop that can be used as either an input or output register.

Figure 1. FLEX 8000 Device Block Diagram


Signal interconnections within FLEX 8000 devices and between device pins are provided by the FastTrack Interconnect, a series of fast, continuous channels that run the entire length and width of the device. IOEs are located at the end of each row (horizontal) and column (vertical) FastTrack Interconnect path.

## Logic Array Block

A logic array block (LAB) consists of eight LEs, their associated carry and cascade chains, LAB control signals, and the LAB local interconnect. The LAB provides the coarse-grained structure of the FLEX 8000 architecture. This structure enables FLEX 8000 devices to provide efficient routing, high device utilization, and high performance. Figure 2 shows a block diagram of the FLEX 8000 LAB.

Figure 2. FLEX 8000 Logic Array Block


Each LAB provides four control signals that can be used in all eight LEs. Two of these signals can be used as clocks, and the other two for clear/preset control. The LAB control signals can be driven directly from a dedicated input pin, an I/O pin, or any internal signal via the LAB local interconnect. The dedicated inputs are typically used for global clock, clear, or preset signals because they provide synchronous control with very low skew across the device. FLEX 8000 devices support up to four individual global clock, clear, or preset control signals. If logic is required on a control signal, it can be generated in one or more LEs in any LAB and driven into the local interconnect of the target LAB. This process is called programmable inversion, and is available for all four LAB control signals.

## Logic Element

The logic element (LE) is the smallest unit of logic in the FLEX 8000 architecture, with a compact size that provides efficient logic utilization. Each LE contains a 4 -input LUT, a programmable flipflop, a carry chain, and cascade chain. Figure 3 shows a block diagram of an LE.

Figure 3. FLEX 8000 LE


The LUT is a function generator that can quickly compute any function of four variables. The programmable flipflop in the LE can be configured for D, T, JK, or SR operation. The clock, clear, and preset control signals on the flipflop can be driven by dedicated input pins, general-purpose I/O pins, or any internal logic. For purely combinatorial functions, the flipflop is bypassed and the output of the LUT goes directly to the output of the LE.

The FLEX 8000 architecture provides two dedicated high-speed data paths-carry chains and cascade chains-that connect adjacent LEs without using local interconnect paths. The carry chain supports highspeed counters and adders; the cascade chain implements wide-input functions with minimum delay. Carry and cascade chains connect all LEs in an LAB and all LABs in the same row. Heavy use of carry and cascade chains can reduce routing flexibility. Therefore, the use of carry and cascade chains should be limited to speed-critical portions of a design.

## Carry Chain

The carry chain provides a very fast (less than 1 ns ) carry-forward function between LEs. The carry-in signal from a lower-order bit moves forward into the higher-order bit via the carry chain, and feeds into both the LUT and the next portion of the carry chain. This feature allows the FLEX 8000 architecture to implement high-speed counters and adders of arbitrary width. The MAX+PLUS II Compiler can create carry chains automatically during design processing; designers can also insert carry chain logic manually during design entry.

Figure 4 shows how an $n$-bit full adder can be implemented in $n+1$ LEs with the carry chain. One portion of the LUT generates the sum of two bits using the input signals and the carry-in signal; the sum is routed to the output of the LE. The register is typically bypassed for simple adders, but can be used for an accumulator function. Another portion of the LUT and the carry chain logic generate the carry-out signal, which is routed directly to the carry-in signal of the next-higher-order bit. The final carry-out signal is routed to another LE, where it can be used as a general-purpose signal. In addition to mathematical functions, carry chain logic supports very fast counters and comparators.

Figure 4. FLEX 8000 Carry Chain Operation


## Cascade Chain

With the cascade chain, the FLEX 8000 architecture can implement functions that have a very wide fan-in. Adjacent LUTs can be used to compute portions of the function in parallel; the cascade chain serially connects the intermediate values. The cascade chain can use a logical AND or logical OR (via De Morgan's inversion) to connect the outputs of adjacent LEs. Each additional LE provides four more inputs to the effective width of a function, with a delay as low as 0.6 ns per LE.

The MAX+PLUS II Compiler can create cascade chains automatically during design processing; designers can also insert cascade chain logic manually during design entry. Cascade chains longer than eight LEs are automatically implemented by linking LABs together. The last LE of an LAB cascades to the first LE in the next LAB in the row.

Figure 5 shows how the cascade function can connect adjacent LEs to form functions with a wide fan-in. These examples show functions of $4 n$ variables implemented with $n$ LEs. For a device with an A-2 speed grade, the LUT delay is approximately 1.6 ns ; the cascade chain delay is 0.6 ns . With the cascade chain, 4.2 ns is needed to decode a 16-bit address.

Figure 5. FLEX 8000 Cascade Chain Operation

AND Cascade Chain


OR Cascade Chain


## LE Operating Modes

The FLEX 8000 LE can operate in one of four modes, each of which uses LE resources differently. See Figure 6. In each mode, seven of the ten available inputs to the LE-the four data inputs from the LAB local interconnect, the feedback from the programmable register, and the carry-in and cascade-in from the previous LE-are directed to different destinations to implement the desired logic function. The three remaining inputs to the LE provide clock, clear, and preset control for the register. The MAX + PLUS II software automatically chooses the appropriate mode for each application. Design performance can also be enhanced by designing for the operating mode that supports the desired application.

## Figure 6. FLEX 8000 LE Operating Modes

## Normal Mode



Arithmetic Mode


## Up/Down



## Clearable Counter Mode



## Normal Mode

The normal mode is suitable for general logic applications and wide decoding functions that can take advantage of a cascade chain. In normal mode, four data inputs from the LAB local interconnect and the carry-in signal are the inputs to a 4-input LUT. Using a configurable SRAM bit, the MAX+PLUS II Compiler automatically selects the carry-in or the DATA3 signal as an input. The LUT output can be combined with the cascade-in signal to form a cascade chain through the cascade-out signal. The LE-Out signal-the data output of the LE-is either the combinatorial output of the LUT and cascade chain, or the data output (Q) of the programmable register.

## Arithmetic Mode

The arithmetic mode offers two 3-input LUTs that are ideal for implementing adders, accumulators, and comparators. One LUT provides a 3-bit function; the other generates a carry bit. As shown in Figure 6, the first LUT uses the carry-in signal and two data inputs from the LAB local interconnect to generate a combinatorial or registered output. For example, in an adder, this output is the sum of three bits: $a, b$, and the carry-in. The second LUT uses the same three signals to generate a carry-out signal, thereby creating a carry chain. The arithmetic mode also supports a cascade chain.

## Up/Down Counter Mode

The up/down counter mode offers counter enable, synchronous up/down control, and data loading options. These control signals are generated by the data inputs from the LAB local interconnect, the carry-in signal, and output feedback from the programmable register. Two 3-input LUTs are used: one generates the counter data, and the other generates the fast carry bit. A 2-to-1 multiplexer provides synchronous loading. Data can also be loaded asynchronously with the clear and preset register control signals, without using the LUT resources.

## Clearable Counter Mode

The clearable counter mode is similar to the up/down counter mode, but supports a synchronous clear instead of the up/down control; the clear function is substituted for the cascade-in signal in the up/down counter mode. Two 3-input LUTs are used: one generates the counter data, and the other generates the fast carry bit. Synchronous loading is provided by a 2-to-1 multiplexer, and the output of this multiplexer is ANDed with a synchronous clear.

## Internal Tri-State Emulation

Internal tri-state emulation provides internal tri-stating without the limitations of a physical tri-state bus. In a physical tri-state bus, the tri-state buffers' output enable signals select the signal that drives the bus. However, if multiple output enable signals are active, contending signals can be driven onto the bus. Conversely, if no output enable signals are active, the bus will float. Internal tri-state emulation resolves contending tri-state buffers to a low value and floating buses to a high value, thereby eliminating these problems. The MAX+PLUS II software automatically implements tri-state bus functionality with a multiplexer.

## Clear \& Preset Logic Control

Logic for the programmable register's clear and preset functions is controlled by the DATA3, LABCTRL1, and LABCTRL2 inputs to the LE. The clear and preset control structure of the LE is used to asynchronously load signals into a register. The register can be set up so that LABCTRL1 implements an asynchronous load. The data to be loaded is driven to DATA3; when LABCTRL1 is asserted, DATA3 is loaded into the register.

During compilation, the MAX+PLUS II Compiler automatically selects the best control signal implementation. Because the clear and preset functions are active-low, the Compiler automatically assigns a logic high to an unused clear or preset.

The clear and preset logic is implemented in one of the following six asynchronous modes, which are chosen during design entry. LPM functions that use registers will automatically use the correct asynchronous mode. See Figure 7.

- Clear only
- Preset only
- Clear and preset
- Load with clear
- Load with preset
- Load without clear or preset

Figure 7. FLEX 8000 LE Asynchronous Clear \& Preset Modes

Asynchronous Clear


Asynchronous Preset
LABCTRL1 or
LABCTRL2

Asynchronous Clear \& Preset
LABCTRL1


Asynchronous Load with Clear


Asynchronous Load with Preset


Asynchronous Load without Clear or Preset


## Asynchronous Clear

A register is cleared by one of the two LABCTRL signals. When the CLRn port receives a low signal, the register is set to zero.

## Asynchronous Preset

An asynchronous preset is implemented as either an asynchronous load or an asynchronous clear. If DATA3 is tied to VCC, asserting LABCTRLI asynchronously loads a 1 into the register. Alternatively, the MAX+PLUS II software can provide preset control by using the clear and inverting the input and output of the register. Inversion control is available for the inputs to both LEs and IOEs. Therefore, if a register is preset by only one of the two LABCTRL signals, the DATA3 input is not needed and can be used for one of the LE operating modes.

## Asynchronous Clear \& Preset

When implementing asynchronous clear and preset, LABCTRL1 controls the preset and LABCTRL2 controls the clear. The DATA3 input is tied to VCC; therefore, asserting LABCTRL1 asynchronously loads a 1 into the register, effectively presetting the register. Asserting LABCTRL2 clears the register.

## Asynchronous Load with Clear

When implementing an asynchronous load with the clear, LABCTRL1 implements the asynchronous load of DATA3 by controlling the register preset and clear. LABCTRL2 implements the clear by controlling the register clear.

## Asynchronous Load with Preset

When implementing an asynchronous load in conjunction with a preset, the MAX+PLUS II software provides preset control by using the clear and inverting the input and output of the register. Asserting LABCTRL2 clears the register, while asserting LABCTRL1 loads the register. The MAX + PLUS II software inverts the signal that drives the DATA 3 signal to account for the inversion of the register's output.

## Asynchronous Load without Clear or Preset

When implementing an asynchronous load without the clear or preset, LABCTRL1 implements the asynchronous load of DATA3 by controlling the register preset and clear.

## FastTrack Interconnect

In the FLEX 8000 architecture, connections between LEs and device I/O pins are provided by the FastTrack Interconnect, a series of continuous horizontal (row) and vertical (column) routing channels that traverse the entire FLEX 8000 device. This device-wide routing structure provides predictable performance even in complex designs. In contrast, the segmented routing structure in FPGAs requires switch matrices to connect a variable number of routing paths, which increases the delays between logic resources and reduces performance.

The LABs within FLEX 8000 devices are arranged into a matrix of columns and rows. Each row of LABs has a dedicated row interconnect that routes signals both into and out of the LABs in the row. The row interconnect can then drive I/O pins or feed other LABs in the device. Figure 8 shows how an LE drives the row and column interconnect.

Figure 8. FLEX 8000 LAB Connections to Row \& Column Interconnect


Note:
(1) See Table 4 for the number of row channels.

Each LE in an LAB can drive up to two separate column interconnect channels. Therefore, all 16 available column channels can be driven by the LAB. The column channels run vertically across the entire device, and share access to LABs in the same column but in different rows. The MAX+PLUS II Compiler chooses which LEs must be connected to a column channel. A row interconnect channel can be fed by the output of the LE or by two column channels. These three signals feed a multiplexer that connects to a specific row channel. Each LE is connected to one 3-to-1 multiplexer. In an LAB, the multiplexers provide all 16 column channels with access to 8 row channels.

Each column of LABs has a dedicated column interconnect that routes signals out of the LABs into the column. The column interconnect can then drive I/O pins or feed into the row interconnect to route the signals to other LABs in the device. A signal from the column interconnect, which can be either the output of an LE or an input from an I/O pin, must transfer to the row interconnect before it can enter an LAB. Table 4 summarizes the FastTrack Interconnect resources available in each FLEX 8000 device.

Table 4. FLEX 8000 FastTrack Interconnect Resources

| Device | Rows | Channels per Row | Columns | Channels per Column |
| :--- | :---: | :---: | :---: | :---: |
| EPF8282A <br> EPF8282AV | 2 | 168 | 13 | 16 |
| EPF8452A | 2 | 168 | 21 | 16 |
| EPF8636A | 3 | 168 | 21 | 16 |
| EPF8820A | 4 | 168 | 21 | 16 |
| EPF81188A | 6 | 168 | 21 | 16 |
| EPF81500A | 6 | 216 | 27 | 16 |

Figure 9 shows the interconnection of four adjacent LABs, with row, column, and local interconnects, as well as the associated cascade and carry chains.

## Figure 9. FLEX 8000 Device Interconnect Resources

Each LAB is named according to its physical row (A, B, C, etc.) and column (1, 2, 3, etc.) position within the device.


## I/O Element

An IOE contains a bidirectional I/O buffer and a register that can be used either as an input register for external data that requires a fast setup time, or as an output register for data that requires fast clock-to-output performance. IOEs can be used as input, output, or bidirectional pins. The MAX+PLUS II Compiler uses the programmable inversion option to automatically invert signals from the row and column interconnect where appropriate. Figure 10 shows the IOE block diagram.

## Figure 10. FLEX 8000 IOE

Numbers in parentheses are for EPF81500A devices only.


## Row-to-IOE Connections

Figure 11 illustrates the connection between row interconnect channels and IOEs. An input signal from an IOE can drive two separate row channels. When an IOE is used as an output, the signal is driven by an $n$-to- 1 multiplexer that selects the row channels. The size of the multiplexer varies with the number of columns in a device. EPF81500A devices use a 27-to-1 multiplexer; EPF81188A, EPF8820A, EPF8636A, and EPF8452A devices use a 21-to-1 multiplexer; and EPF8282A and EPF8282AV devices use a 13-to-1 multiplexer. Eight IOEs are connected to each side of the row channels.

## Figure 11. FLEX 8000 Row-to-IOE Connections

Numbers in parentheses are for EPF81500A devices. See Note (1).


Note:
(1) $n=13$ for EPF8282A and EPF8282AV devices.
$n=21$ for EPF8452A, EPF8636A, EPF8820A, and EPF81188A devices.
$n=27$ for EPF81500A devices.

## Column-to-IOE Connections

Two IOEs are located at the top and bottom of the column channels (see Figure 12). When an IOE is used as an input, it can drive up to two separate column channels. The output signal to an IOE can choose from 8 of the 16 column channels through an 8-to-1 multiplexer.

Figure 12. FLEX 8000 Column-to-IOE Connections


In addition to general-purpose I/O pins, FLEX 8000 devices have four dedicated input pins. These dedicated inputs provide low-skew, devicewide signal distribution, and are typically used for global clock, clear, and preset control signals. The signals from the dedicated inputs are available as control signals for all LABs and I/O elements in the device. The dedicated inputs can also be used as general-purpose data inputs because they can feed the local interconnect of each LAB in the device.

Signals enter the FLEX 8000 device either from the I/O pins that provide general-purpose input capability or from the four dedicated inputs. The IOEs are located at the ends of the row and column interconnect channels.

I/O pins can be used as input, output, or bidirectional pins. Each I/O pin has a register that can be used either as an input register for external data that requires fast setup times, or as an output register for data that requires fast clock-to-output performance. The MAX+PLUS II Compiler uses the programmable inversion option to automatically invert signals from the row and column interconnect when appropriate.

The clock, clear, and output enable controls for the IOEs are provided by a network of I/O control signals. These signals can be supplied by either the dedicated input pins or by internal logic. The IOE control-signal paths are designed to minimize the skew across the device. All control-signal sources are buffered onto high-speed drivers that drive the signals around the periphery of the device. This "peripheral bus" can be configured to provide up to four output enable signals (10 in EPF81500A devices), and up to two clock or clear signals. Figure 13 shows how two output enable signals are shared with one clock and one clear signal.

The signals for the peripheral bus can be generated by any of the four dedicated inputs or signals on the row interconnect channels, as shown in Figure 13. The number of row channels in a row that can drive the peripheral bus correlates to the number of columns in the FLEX 8000 device. EPF8282A and EPF8282AV devices use 13 channels; EPF8452A, EPF8636A, EPF8820A, and EPF81188A devices use 21 channels; and EPF81500A devices use 27 channels. The first LE in each LAB is the source of the row channel signal. The six peripheral control signals (12 in EPF81500A devices) can be accessed by each IOE.

Figure 13. FLEX 8000 Peripheral Bus
Numbers in parentheses are for EPF81500A devices.


## Note:

(1) $n=13$ for EPF8282A and EPF8282AV devices.
$n=21$ for EPF8452A, EPF8636A, EPF8820A, and EPF81188A devices.
$n=27$ for EPF81500A devices.

Table 5 lists the source of the peripheral control signal for each FLEX 8000 device by row.

Table 5. Row Sources of FLEX 8000 Peripheral Control Signals

| Peripheral <br> Control Signal | EPF8282A <br> EPF8282AV | EPF8452A | EPF8636A | EPF8820A | EPF81188A | EPF81500A |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| CLK0 | Row A | Row A | Row A | Row A | Row E | Row E |
| CLK1/OE1 | Row B | Row B | Row C | Row C | Row B | Row B |
| CLR0 | Row A | Row A | Row B | Row B | Row F | Row F |
| CLR1/OE0 | Row B | Row B | Row C | Row D | Row C | Row C |
| OE2 | Row A | Row A | Row A | Row A | Row D | Row A |
| OE3 | Row B | Row B | Row B | Row B | Row A | Row A |
| OE4 | - | - | - | - | - | Row B |
| OE5 | - | - | - | - | - | Row C |
| OE6 | - | - | - | - | - | Row D |
| OE7 | - | - | - | - | - | Row D |
| OE8 | - | - | - | - | - | Row E |
| OE9 | - | - | - | - | - | Row F |

## Output Configuration

This section discusses slew-rate control and MultiVolt I/O interface operation for FLEX 8000 devices.

## Slew-Rate Control

The output buffer in each IOE has an adjustable output slew rate that can be configured for low-noise or high-speed performance. A slow slew rate reduces system noise by slowing signal transitions, adding a maximum delay of 3.5 ns . The slow slew-rate setting affects only the falling edge of a signal. The fast slew rate should be used for speed-critical outputs in systems that are adequately protected against noise. Designers can specify the slew rate on a pin-by-pin basis during design entry or assign a default slew rate to all pins on a global basis.

For more information on high-speed system design, go to Application Note 75 (High-Speed Board Designs) in this data book.

## MultiVolt I/O Interface

The FLEX 8000 device architecture supports the MultiVolt I/O interface feature, which allows EPF81500A, EPF81188A, EPF8820A, and EPF8636A devices to interface with systems with differing supply voltages. These devices in all packages-except for EPF8636A devices in 84-pin PLCC packages-can be set for $3.3-\mathrm{V}$ or $5.0-\mathrm{V}$ I/O pin operation. These devices have one set of $\mathrm{V}_{\mathrm{CC}}$ pins for internal operation and input buffers (VCCINT), and another set for I/O output drivers (VCCIO).

The VCCINT pins must always be connected to a 5.0-V power supply. With a $5.0-\mathrm{V} \mathrm{V}_{\mathrm{CCINT}}$ level, input voltages are at TTL levels and are therefore compatible with $3.3-\mathrm{V}$ and $5.0-\mathrm{V}$ inputs.

The VCCIO pins can be connected to either a $3.3-\mathrm{V}$ or $5.0-\mathrm{V}$ power supply, depending on the output requirements. When the VCCIO pins are connected to a $5.0-\mathrm{V}$ power supply, the output levels are compatible with $5.0-\mathrm{V}$ systems. When the VCCIO pins are connected to a $3.3-\mathrm{V}$ power supply, the output high is at 3.3 V and is therefore compatible with $3.3-\mathrm{V}$ or $5.0-\mathrm{V}$ systems. Devices operating with $\mathrm{V}_{\mathrm{CCIO}}$ levels lower than 4.75 V incur a nominally greater timing delay of $t_{O D 2}$ instead of $t_{O D 1}$. See Table 7 on page 26 .

## IEEE 1149.1 (JTAG) Boundary-Scan Support

The EPF8282A, EPF8282AV, EPF8636A, EPF8820A, and EPF81500A devices provide JTAG BST circuitry. FLEX 8000 devices with JTAG circuitry support the JTAG instructions shown in Table 6. Figure 14 shows the timing requirements for the JTAG signals.

| Table 6. EPF8282A, EPF8282AV, EPF8636A, EPF8820A \& EPF81500A JTAG Instructions |  |
| :--- | :--- |
| JTAG Instruction | $\quad$ Description |
| SAMPLE/PRELOAD | Allows a snapshot of the signals at the device pins to be captured and examined during <br> normal device operation, and permits an initial data pattern to be output at the device pins. |
| EXTEST | Allows the external circuitry and board-level interconnections to be tested by forcing a test <br> pattern at the output pins and capturing test results at the input pins. |
| BYPASS | Places the 1-bit bypass register between the TDI and TDO pins, which allows the BST <br> data to pass synchronously through the selected device to adjacent devices during <br> normal device operation. |

Figure 14. EPF8282A, EPF8282AV, EPF8636A, EPF8820A \& EPF81500A JTAG Waveforms


Table 7 shows the timing parameters and values for EPF8282A, EPF8282AV, EPF8636A, EPF8820A, and EPF81500A devices.

| Table 7. JTAG Timing Parameters \& Values |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
| Symbol | Parameter | EPF8282A <br> EPF8282AV <br> EPF8636A <br> EPF8820A <br> EPF81500A |  | Unit |
|  |  | Min | Max |  |
| $\mathrm{t}_{\text {JCP }}$ | тСК clock period | 100 |  | ns |
| $\mathrm{t}_{\mathrm{JCH}}$ | TCK clock high time | 50 |  | ns |
| $\mathrm{t}_{\text {JCL }}$ | TCK clock low time | 50 |  | ns |
| $\mathrm{t}_{\text {JPSU }}$ | JTAG port setup time | 20 |  | ns |
| $\mathrm{t}_{\text {JPH }}$ | JTAG port hold time | 45 |  | ns |
| $\mathrm{t}_{\text {JPCO }}$ | JTAG port clock to output |  | 25 | ns |
| $\mathrm{t}_{\text {JPZX }}$ | JTAG port high-impedance to valid output |  | 25 | ns |
| $\mathrm{t}_{\text {JPXZ }}$ | JTAG port valid output to high-impedance |  | 25 | ns |
| $\mathrm{t}_{\text {JSSU }}$ | Capture register setup time | 20 |  | ns |
| $\mathrm{t}_{\text {JSH }}$ | Capture register hold time | 45 |  | ns |
| $\mathrm{t}_{\text {JSCO }}$ | Update register clock to output |  | 35 | ns |
| $\mathrm{t}_{\text {JSzx }}$ | Update register high-impedance to valid output |  | 35 | ns |
| $\mathrm{t}_{\mathrm{JSXZ}}$ | Update register valid output to high-impedance |  | 35 | ns |

For detailed information on JTAG operation in FLEX 8000 devices, refer to Application Note 39 (JTAG Boundary-Scan Testing in Altera Devices).

## Generic Testing

Each FLEX 8000 device is functionally tested and specified by Altera.
Complete testing of each configurable SRAM bit and all logic functionality ensures $100 \%$ configuration yield. AC test measurements for FLEX 8000 devices are made under conditions equivalent to those shown in Figure 15. Designers can use multiple test patterns to configure devices during all stages of the production flow.

Figure 15. FLEX 8000 AC Test Conditions
Power supply transients can affect AC measurements. Simultaneous transitions of multiple outputs should be avoided for accurate measurement. Threshold tests must not be performed under AC conditions.
Large-amplitude, fast-ground-current transients normally occur as the device outputs discharge the load capacitances. When these transients flow through the parasitic inductance between the device ground pin and the test system ground, significant reductions in observable noise immunity can result. Numbers in


## Operating Conditions

The following tables provide information on absolute maximum ratings, recommended operating conditions, operating conditions, and capacitance for 5.0-V and 3.3-V FLEX 8000 devices.

## FLEX 8000 5.0-V Device Absolute Maximum Ratings Note (1)

| Symbol | Parameter | Conditions | Min | Max | Unit |
| :--- | :--- | :--- | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply voltage | With respect to ground, Note (2) | -2.0 | 7.0 | $\mathrm{~V}^{2}$ |
| $\mathrm{~V}_{\mathrm{I}}$ | DC input voltage |  | -2.0 | 7.0 | V |
| $\mathrm{I}_{\text {OUT }}$ | DC output current, per pin |  | -25 | 25 | mA |
| $\mathrm{~T}_{\text {STG }}$ | Storage temperature | No bias | -65 | 150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {AMB }}$ | Ambient temperature | Under bias | -65 | 135 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{J}$ | Junction temperature | Ceramic packages, under bias |  | 150 | ${ }^{\circ} \mathrm{C}$ |
|  |  |  | PQFP and RQFP, under bias |  | 135 |

## FLEX 8000 5.0-V Device Recommended Operating Conditions

| Symbol | Parameter | Conditions | Min | Max | Unit |
| :--- | :--- | :--- | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CCINT}}$ | Supply voltage for internal logic and <br> input buffers | Notes (3), (4) | $4.75(4.50)$ | $5.25(5.50)$ | V |
| $\mathrm{V}_{\mathrm{CCIO}}$ | Supply voltage for output buffers, <br> $5.0-\mathrm{V}$ operation | Notes (3), (4) | $4.75(4.50)$ | $5.25(5.50)$ | V |
|  | Supply voltage for output buffers, <br> $3.3-\mathrm{V}$ operation | Notes (3), (4) | $3.00(3.00)$ | $3.60(3.60)$ | V |
|  | Input voltage |  | 0 | $\mathrm{~V}_{\mathrm{CCINT}}$ | V |
|  | Output voltage |  | 0 | $\mathrm{~V}_{\mathrm{CCIO}}$ | V |
| $\mathrm{T}_{\mathrm{A}}$ | Operating temperature | For commercial use | 0 | 70 | ${ }^{\circ} \mathrm{C}$ |
|  |  | For industrial use | -40 | 85 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{t}_{\mathrm{R}}$ | Input rise time |  |  | 40 | ns |
| $\mathrm{t}_{\mathrm{F}}$ | Input fall time |  |  | 40 | ns |

## FLEX 8000 5.0-V Device DC Operating Conditions Notes (5), (6)

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{IH}}$ | High-level input voltage |  | 2.0 |  | $\begin{gathered} \mathrm{V}_{\mathrm{CCINT}}+ \\ 0.3 \end{gathered}$ | V |
| $\mathrm{V}_{\text {IL }}$ | Low-level input voltage |  | -0.3 |  | 0.8 | V |
| $\mathrm{V}_{\mathrm{OH}}$ | 5.0-V high-level TTL output voltage | $\mathrm{I}_{\mathrm{OH}}=-4 \mathrm{~mA} \mathrm{DC}, \operatorname{Note}(7)$ $\mathrm{V}_{\mathrm{CCIO}}=4.75 \mathrm{~V}$ | 2.4 |  |  | V |
|  | 3.3-V high-level TTL output voltage | $\mathrm{I}_{\mathrm{OH}}=-4 \mathrm{~mA} \mathrm{DC}, \text { Note (7) }$ $\mathrm{V}_{\mathrm{CCIO}}=3.00 \mathrm{~V}$ | 2.4 |  |  | V |
|  | 3.3-V high-level CMOS output voltage | $\begin{aligned} & \hline \mathrm{I}_{\mathrm{OH}}=-0.1 \mathrm{~mA} \mathrm{DC}, \text { Note }(7) \\ & \mathrm{V}_{\mathrm{CCIO}}=3.00 \mathrm{~V} \\ & \hline \end{aligned}$ | $\mathrm{V}_{\mathrm{CCIO}}-0.2$ |  |  | V |
| $\mathrm{V}_{\mathrm{OL}}$ | 5.0-V low-level TTL output voltage | $\begin{array}{\|l} \hline \mathrm{I}_{\mathrm{OL}}=12 \mathrm{~mA} \mathrm{DC}, \text { Note }(7) \\ \mathrm{V}_{\mathrm{CCIO}}=4.75 \mathrm{~V} \\ \hline \end{array}$ |  |  | 0.45 | V |
|  | 3.3-V low-level TTL output voltage | $\begin{aligned} & \mathrm{I} \\ & \mathrm{OL}=12 \mathrm{~mA} \mathrm{DC}, \text { Note }(7) \\ & \mathrm{V}_{\mathrm{CCIO}}=3.00 \mathrm{~V} \\ & \hline \end{aligned}$ |  |  | 0.45 | V |
|  | 3.3-V low-level CMOS output voltage | $\begin{array}{\|l\|} \hline \mathrm{I}_{\mathrm{OL}}=0.1 \mathrm{~mA} \mathrm{DC}, \text { Note }(7) \\ \mathrm{V}_{\mathrm{CCIO}}=3.00 \mathrm{~V} \\ \hline \end{array}$ |  |  | 0.2 | V |
| $\mathrm{I}_{1}$ | Input leakage current | $\mathrm{V}_{1}=\mathrm{V}_{\mathrm{CC}}$ or ground | -10 |  | 10 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{OZ}}$ | Tri-state output off-state current | $\mathrm{V}_{\mathrm{O}}=\mathrm{V}_{\mathrm{CC}}$ or ground | -40 |  | 40 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {CC0 }}$ | $\mathrm{V}_{\text {CC }}$ supply current (standby) | $\mathrm{V}_{1}=$ ground, no load |  | 0.5 | 10 | mA |

## FLEX 8000 5.0-V Device Capacitance Note (8)

| Symbol | Parameter | Conditions | Min | Max | Unit |
| :--- | :--- | :--- | :---: | :---: | :---: |
| $\mathrm{C}_{\mathrm{IN}}$ | Input capacitance | $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}, \mathrm{f}=1.0 \mathrm{MHz}$ |  | 10 | pF |
| $\mathrm{C}_{\text {OUT }}$ | Output capacitance | $\mathrm{V}_{\text {OUT }}=0 \mathrm{~V}, \mathrm{f}=1.0 \mathrm{MHz}$ |  | 10 | pF |

Notes to tables:
(1) See the Operating Requirements for Altera Devices Data Sheet in this data book.
(2) Minimum DC input is -0.3 V . During transitions, the inputs may undershoot to -2.0 V or overshoot to 7.0 V for periods shorter than 20 ns under no-load conditions.
(3) The maximum $V_{C C}$ rise time is 100 ms .
(4) Numbers in parentheses are for industrial-temperature-range devices.
(5) Typical values are for $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ and $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}$.
(6) These values are specified under "FLEX 8000 5.0-V Device Recommended Operating Conditions" on page 27.
(7) The $\mathrm{I}_{\mathrm{OH}}$ parameter refers to high-level TTL or CMOS output current; the $\mathrm{I}_{\mathrm{OL}}$ parameter refers to low-level TTL or CMOS output current.
(8) Capacitance is sample-tested only.

## FLEX 8000 3.3-V Device Absolute Maximum Ratings

Note (1)

| Symbol | Parameter | Conditions | Min | Max | Unit |
| :--- | :--- | :--- | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply voltage | With respect to ground, Note (2) | -2.0 | 5.3 | V |
| $\mathrm{~V}_{\mathrm{I}}$ | DC input voltage |  | -2.0 | 5.3 | V |
| $\mathrm{I}_{\mathrm{OUT}}$ | DC output current, per pin |  | -25 | 25 | mA |
| $\mathrm{~T}_{\text {STG }}$ | Storage temperature | No bias | -65 | 150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {AMB }}$ | Ambient temperature | Under bias | -65 | 135 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{J}$ | Junction temperature | Plastic packages, under bias |  | 135 | ${ }^{\circ} \mathrm{C}$ |

## FLEX 8000 3.3-V Device Recommended Operating Conditions

| Symbol | Parameter | Conditions | Min | Max | Unit |
| :--- | :--- | :--- | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply voltage | Note (3) | 3.0 | 3.6 | V |
| $\mathrm{~V}_{\mathrm{I}}$ | Input voltage |  | 0 | $\mathrm{~V}_{\mathrm{CC}}$ | V |
| $\mathrm{V}_{\mathrm{O}}$ | Output voltage |  | 0 | $\mathrm{~V}_{\mathrm{CC}}$ | V |
| $\mathrm{T}_{\mathrm{A}}$ | Operating temperature | For commercial use | 0 | 70 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{t}_{\mathrm{R}}$ | Input rise time |  |  | 40 | ns |
| $\mathrm{t}_{\mathrm{F}}$ | Input fall time |  |  | 40 | ns |

## FLEX 8000 3.3-V Device DC Operating Conditions

Note (4)

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
| :--- | :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{IH}}$ | High-level input voltage |  | 2.0 |  | $\mathrm{~V}_{\mathrm{CC}}+0.3$ | V |
| $\mathrm{~V}_{\mathrm{IL}}$ | Low-level input voltage |  | -0.3 |  | 0.8 | V |
| $\mathrm{~V}_{\mathrm{OH}}$ | High-level output voltage | $\mathrm{I}_{\mathrm{OH}}=-0.1 \mathrm{~mA} \mathrm{DC}$, Note $(5)$ | $\mathrm{V}_{\mathrm{CC}}-0.2$ |  |  | V |
| $\mathrm{~V}_{\mathrm{OL}}$ | Low-level output voltage | $\mathrm{I}_{\mathrm{OL}}=4 \mathrm{~mA} \mathrm{DC}$, Note $(5)$ |  |  | 0.45 | V |
| $\mathrm{I}_{\mathrm{I}}$ | Input leakage current | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CC}}$ or ground | -10 |  | 10 | $\mu \mathrm{~A}$ |
| $\mathrm{I}_{\mathrm{OZ}}$ | Tri-state output off-state current | $\mathrm{V}_{\mathrm{O}}=\mathrm{V}_{\mathrm{CC}}$ or ground | -40 |  | 40 | $\mu \mathrm{~A}$ |
| $\mathrm{I}_{\mathrm{CCO}}$ | $\mathrm{V}_{\mathrm{CC}}$ supply current (standby) | $\mathrm{V}_{\mathrm{I}}=$ ground, no load, Note $(6)$ |  | 0.3 | 10 | mA |

## FLEX 8000 3.3-V Device Capacitance Note (7)

| Symbol | Parameter | Conditions | Min | Max | Unit |
| :--- | :--- | :--- | :---: | :---: | :---: |
| $\mathrm{C}_{\text {IN }}$ | Input capacitance | $\mathrm{V}_{\text {IN }}=0 \mathrm{~V}, \mathrm{f}=1.0 \mathrm{MHz}$ |  | 10 | pF |
| $\mathrm{C}_{\text {OUT }}$ | Output capacitance | $\mathrm{V}_{\text {OUT }}=0 \mathrm{~V}, \mathrm{f}=1.0 \mathrm{MHz}$ |  | 10 | pF |

## Notes to tables:

(1) See the Operating Requirements for Altera Devices Data Sheet in this data book.
(2) Minimum DC input is -0.3 V . During transitions, the inputs may undershoot to -2.0 V or overshoot to 5.3 V for periods shorter than 20 ns under no-load conditions.
(3) The maximum $\mathrm{V}_{\mathrm{CC}}$ rise time is 100 ms . $\mathrm{V}_{\mathrm{CC}}$ must rise monotonically.
(4) These values are specified under "FLEX 8000 3.3-V Device Recommended Operating Conditions" on page 29.
(5) The $\mathrm{I}_{\mathrm{OH}}$ parameter refers to high-level TTL output current; the $\mathrm{I}_{\mathrm{OL}}$ parameter refers to low-level TTL output current.
(6) Typical values are for $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ and $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}$.
(7) Capacitance is sample-tested only.

Figures 16 and 17 show the typical output drive characteristics of $5.0-\mathrm{V}$ FLEX 8000 devices. The output driver is compliant with the PCI Local Bus Specification, Revision 2.1.

## Figure 16. Output Drive Characteristics of 5.0-V FLEX 8000 Devices (except EPF8282A)




Figure 17. Output Drive Characteristics of EPF8282A Devices with 5.0-V V Ccıo


Figure 18 shows the typical output drive characteristics of EPF8282AV devices.

Figure 18. Output Drive Characteristics of EPF8282AV Devices


## Timing Model

The continuous, high-performance FastTrack Interconnect routing structure ensures predictable performance and accurate simulation and timing analysis. This predictable performance contrasts with that of FPGAs, which use a segmented connection scheme and hence have unpredictable performance. Timing simulation and delay prediction are available with the MAX+PLUS II Simulator and Timing Analyzer, or with industry-standard EDA tools. The Simulator offers both pre-synthesis functional simulation to evaluate logic design accuracy and postsynthesis timing simulation with 0.1-ns resolution. The Timing Analyzer provides point-to-point timing delay information, setup and hold time prediction, and device-wide performance analysis.

Tables 8 through 11 describe the FLEX 8000 timing parameters and their symbols.

| Table 8. FLEX 8000 Internal Timing Parameters Note (1) |  |
| :---: | :---: |
| Symbol | Parameter |
| $t_{I O D}$ | IOE register data delay |
| $t_{\text {IOC }}$ | IOE register control signal delay |
| $t_{\text {IOE }}$ | Output enable delay |
| $t_{100}$ | IOE register clock-to-output delay |
| $t_{\text {IOCOMB }}$ | IOE combinatorial delay |
| $t_{\text {IOSU }}$ | IOE register setup time before clock; IOE register recovery time after asynchronous clear |
| $t_{\text {IOH }}$ | IOE register hold time after clock |
| $t_{\text {IOCLR }}$ | IOE register clear delay |
| $t_{\text {IN }}$ | Input pad and buffer delay |
| $t_{O D 1}$ | Output buffer and pad delay, slow slew rate $=$ off, $\mathrm{V}_{\mathrm{CCIO}}=5.0 \mathrm{~V}, \mathrm{C} 1=35 \mathrm{pF}$, Note (2) |
| $t_{\text {OD2 }}$ | Output buffer and pad delay, slow slew rate $=$ off, $\mathrm{V}_{\mathrm{CCIO}}=3.3 \mathrm{~V}, \mathrm{C} 1=35 \mathrm{pF}$, Note (2) |
| $t_{\text {OD3 }}$ | Output buffer and pad delay, slow slew rate = on, C1 = 35 pF , Note (3) |
| $t_{X Z}$ | Output buffer disable delay, C1 $=5 \mathrm{pF}$ |
| $t_{Z X 1}$ | Output buffer enable delay, slow slew rate $=0$ ff, $\mathrm{V}_{\text {CCIO }}=5.0 \mathrm{~V}, \mathrm{C} 1=35 \mathrm{pF}$, Note (2) |
| $t_{Z X 2}$ | Output buffer enable delay, slow slew rate $=$ off, $\mathrm{V}_{\mathrm{CCIO}}=3.3 \mathrm{~V}, \mathrm{C} 1=35 \mathrm{pF}$, Note (2) |
| $t_{Z X 3}$ | Output buffer enable delay, slow slew rate $=$ on, $\mathrm{C} 1=35 \mathrm{pF}$, Note (3) |

Table 9. FLEX 8000 LE Timing Parameters Note (1)

| Symbol |  |
| :--- | :--- |
| $t_{L U T}$ | LUT delay for data-in |
| $t_{C L U T}$ | LUT delay for carry-in |
| $t_{\text {RLUT }}$ | LUT delay for LE register feedback |
| $t_{\text {GATE }}$ | Cascade gate delay |
| $t_{C A S C}$ | Cascade chain routing delay |
| $t_{C I C O}$ | Carry-in to carry-out delay |
| $t_{C G E N}$ | Data-in to carry-out delay |
| $t_{C G E N R}$ | LE register feedback to carry-out delay |
| $t_{C}$ | LE register control signal delay |
| $t_{C H}$ | LE register clock high time |
| $t_{C L}$ | LE register clock low time |
| $t_{C O}$ | LE register clock-to-output delay |
| $t_{C O M B}$ | Combinatorial delay |
| $t_{S U}$ | LE register setup time before clock; LE register recovery time after asynchronous preset, clear, or load |
| $t_{H}$ | LE register hold time after clock |
| $t_{P R E}$ | LE register preset delay |
| $t_{C L R}$ | LE register clear delay |

Table 10. FLEX 8000 Interconnect Timing Parameters Note (1)

| Symbol |  |
| :--- | :--- |
| $t_{\text {LABCASC }}$ | Cascade delay between LEs in different LABs |
| $t_{\text {LABCARRY }}$ | Carry delay between LEs in different LABs |
| $t_{\text {LOCAL }}$ | LAB local interconnect delay |
| $t_{R O W}$ | Row interconnect routing delay, Note (4) |
| $t_{C O L}$ | Column interconnect routing delay |
| $t_{D I N \_C}$ | Dedicated input to LE control delay |
| $t_{\text {DIN } D}$ | Dedicated input to LE data delay, Note (4) |
| $t_{D I N \_I O}$ | Dedicated input to IOE control delay |

Table 11. FLEX 8000 External Reference Timing Characteristics Note (5)

| Symbol | Parameter |
| :--- | :--- |
| t $_{\text {DRR }}$ | Register-to-register delay via 4 LEs, 3 row interconnects, and 4 local interconnects, Note (6) |
| t $_{\text {ODH }}$ | Output data hold time after clock, Note (7) |

## Notes to tables:

(1) Internal timing parameters cannot be measured explicitly. They are worst-case delays based on testable and external parameters specified by Altera. Internal timing parameters should be used for estimating device performance. Post-compilation timing simulation or timing analysis is required to determine actual worst-case performance.
(2) These values are specified under "FLEX 8000 3.3-V Device Recommended Operating Conditions" on page 29.
(3) For the $t_{O D 3}$ and $t_{Z X 3}$ parameters, $\mathrm{V}_{\mathrm{CCIO}}=3.3 \mathrm{~V}$ or 5.0 V .
(4) The $t_{\text {ROW }}$ and $t_{\text {DIN_D }}$ delays are worst-case values for typical applications. Post-compilation timing simulation or timing analysis is required to determine actual worst-case performance.
(5) External reference timing characteristics are factory-tested, worst-case values specified by Altera. A representative subset of signal paths is tested to approximate typical device applications.
(6) For more information on test conditions, see Application Note 76 (Understanding FLEX 8000 Timing) in this data book.
(7) This parameter is a guideline that is sample-tested only and is based on extensive device characterization. This parameter applies to global and non-global clocking, and for LE and I/O element registers.

The FLEX 8000 timing model shows the delays for various paths and functions in the circuit. See Figure 19. This model contains three distinct parts: the LE; the IOE; and the interconnect, including the row and column FastTrack Interconnect, LAB local interconnect, and carry and cascade interconnect paths. Each parameter shown in Figure 19 is expressed as a worst-case value in the "Timing Parameters" tables in this data sheet. Hand-calculations that use the FLEX 8000 timing model and these timing parameters can be used to estimate FLEX 8000 device performance. Timing simulation or timing analysis after compilation is required to determine the final worst-case performance. Table 12 summarizes the interconnect paths shown in Figure 19.

For more information on timing parameters, go to Application Note 76 (Understanding FLEX 8000 Timing) in this data book.

Table 12. FLEX 8000 Timing ModeI Interconnect Paths

| Source | Destination | Total Delay |
| :--- | :--- | :--- |
| LE-Out | LE in same LAB | $t_{\text {LOCAL }}$ |
| LE-Out | LE in same row, different LAB | $t_{R O W}+t_{\text {LOCAL }}$ |
| LE-Out | LE in different row | $t_{C O L}+t_{R O W}+t_{\text {LOCAL }}$ |
| LE-Out | IOE on column | $t_{C O L}$ |
| LE-Out | IOE on row | $t_{R O W}$ |
| IOE on row | LE in same row | $t_{R O W}+t_{\text {LOCAL }}$ |
| IOE on column | Any LE | $t_{C O L}+t_{R O W}+t_{\text {LOCAL }}$ |

Figure 19. FLEX 8000 Timing Model


## EPF8282A Internal Timing Parameters

## EPF8282A I/O Element Timing Parameters

| Symbol | A-2 Speed Grade |  | A-3 Speed Grade |  | A-4 Speed Grade |  | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Max | Min |  | Max | Min |  |
|  |  |  |  |  |  |  |  |
| $t_{I O D}$ |  | 0.7 |  | 0.8 |  | 0.9 | ns |
| $t_{I O C}$ |  | 1.7 |  | 1.8 |  | 1.9 | ns |
| $t_{I O E}$ |  | 1.7 |  | 1.8 |  | 1.9 | ns |
| $t_{I O C O}$ |  | 1.0 |  | 1.0 |  | 1.0 | ns |
| $t_{I O C O M B}$ |  | 0.3 |  | 0.2 |  | 0.1 | ns |
| $t_{I O S U}$ | 1.4 |  | 1.6 |  | 1.8 |  | ns |
| $t_{I O H}$ | 0.0 |  | 0.0 |  | 0.0 |  | ns |
| $t_{I O C L R}$ |  | 1.2 |  | 1.2 |  | 1.2 | ns |
| $t_{I N}$ |  | 1.5 |  | 1.6 |  | 1.7 | ns |
| $t_{O D 1}$ |  | - |  | 1.4 |  | 1.7 | ns |
| $t_{O D 2}$ |  | 4.6 |  | - |  | - | ns |
| $t_{O D 3}$ |  | 1.4 |  | 4.9 |  | 5.2 | ns |
| $t_{X Z}$ |  | 1.4 |  | 1.6 |  | 1.8 | ns |
| $t_{Z X 1}$ |  | - |  | 1.6 |  | 1.8 | ns |
| $t_{Z X 2}$ |  | 4.9 |  | - |  | - | ns |
| $t_{Z X 3}$ |  |  |  |  |  |  | 5.1 |

## EPF8282A Interconnect Timing Parameters

| Symbol | A-2 Speed Grade |  | A-3 Speed Grade |  | A-4 Speed Grade |  | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Max | Min | Max | Min | Max |  |
| $t_{\text {LABCASC }}$ |  | 0.3 |  | 0.3 |  | 0.4 | ns |
| $t_{\text {LABCARRY }}$ |  | 0.3 |  | 0.3 |  | 0.4 | ns |
| $t_{\text {LOCAL }}$ |  | 0.5 |  | 0.6 |  | 0.8 | ns |
| $t_{\text {ROW }}$ |  | 4.2 |  | 4.2 |  | 4.2 | ns |
| $t_{\text {COL }}$ |  | 2.5 |  | 2.5 |  | 2.5 | ns |
| $t_{\text {DIN_C }}$ |  | 5.0 |  | 5.0 |  | 5.5 | ns |
| $t_{\text {DIN_D }}$ |  | 7.2 |  | 7.2 |  | 7.2 | ns |
| $t_{\text {DIN_IO }}$ |  | 5.0 |  | 5.0 |  | 5.5 | ns |

## EPF8282A LE Timing Parameters

| Symbol | A-2 Speed Grade |  | A-3 Speed Grade |  | A-4 Speed Grade |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Max | Min | Max | Min | Max |  |
| $t_{\text {LUT }}$ |  | 2.0 |  | 2.5 |  | 3.2 | ns |
| $t_{\text {CLUT }}$ |  | 0.0 |  | 0.0 |  | 0.0 | ns |
| $t_{\text {RLUT }}$ |  | 0.9 |  | 1.1 |  | 1.5 | ns |
| $t_{\text {GATE }}$ |  | 0.0 |  | 0.0 |  | 0.0 | ns |
| $t_{\text {CASC }}$ |  | 0.6 |  | 0.7 |  | 0.9 | ns |
| $t_{\text {CICO }}$ |  | 0.4 |  | 0.5 |  | 0.6 | ns |
| $t_{\text {CGEN }}$ |  | 0.4 |  | 0.5 |  | 0.7 | ns |
| $t_{\text {CGENR }}$ |  | 0.9 |  | 1.1 |  | 1.5 | ns |
| $t_{C}$ |  | 1.6 |  | 2.0 |  | 2.5 | ns |
| $t_{\text {CH }}$ | 4.0 |  | 4.0 |  | 4.0 |  | ns |
| $t_{C L}$ | 4.0 |  | 4.0 |  | 4.0 |  | ns |
| $t_{\mathrm{CO}}$ |  | 0.4 |  | 0.5 |  | 0.6 | ns |
| $t_{\text {COM }}$ |  | 0.4 |  | 0.5 |  | 0.6 | ns |
| $t_{S U}$ | 0.8 |  | 1.1 |  | 1.2 |  | ns |
| $t_{H}$ | 0.9 |  | 1.1 |  | 1.5 |  | ns |
| $t_{\text {PRE }}$ |  | 0.6 |  | 0.7 |  | 0.8 | ns |
| $t_{C L R}$ |  | 0.6 |  | 0.7 |  | 0.8 | ns |

EPF8282A External Timing Parameters

| Symbol | A-2 Speed Grade |  | A-3 Speed Grade |  | A-4 Speed Grade |  | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Max | Min | Max | Min | Max |  |
| $\boldsymbol{t}_{\text {DRR }}$ |  | 15.8 |  | 19.8 |  | 24.8 | ns |
| $\boldsymbol{t}_{\text {ODH }}$ | 1.0 |  | 1.0 |  | 1.0 |  | ns |

EPF8282AV Internal Timing Parameters

## EPF8282AV I/O Element Timing Parameters

| Symbol | A-3 Speed Grade |  | A-4 Speed Grade |  | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: |
|  | Min | Max | Min | Max |  |
| $t_{I O D}$ |  | 0.9 |  | 2.2 | ns |
| $t_{I O C}$ |  | 1.9 |  | 2.0 | ns |
| $t_{I O E}$ |  | 1.9 |  | 2.0 | ns |
| $t_{I O C O}$ |  | 1.0 |  | 2.0 | ns |
| $t_{I O C O M B}$ |  | 0.1 |  | 0.0 | ns |
| $t_{I O S U}$ | 1.8 |  | 2.8 |  | ns |
| $t_{I O H}$ | 0.0 |  | 0.2 |  | ns |
| $t_{I O C L R}$ |  | 1.2 |  | 2.3 | ns |
| $t_{I N}$ |  | 1.7 |  | 3.4 | ns |
| $t_{O D 1}$ |  | 1.7 |  | 4.1 | ns |
| $t_{O D 2}$ |  | - |  | - | ns |
| $t_{O D 3}$ |  | 5.2 |  | 7.1 | ns |
| $t_{X Z}$ |  | 1.8 |  | 4.3 | ns |
| $t_{Z X 1}$ |  | 1.8 |  | 4.3 | ns |
| $t_{Z X 2}$ |  | - |  | - | ns |
| $t_{Z X 3}$ |  | 5.3 |  | 8.3 | ns |

EPF8282AV Interconnect Timing Parameters

| Symbol | A-3 Speed Grade |  | A-4 Speed Grade |  | Unit |
| :--- | :---: | :---: | ---: | ---: | :---: |
|  | Min | Max | Min | Max |  |
| $t_{\text {LABCASC }}$ |  | 0.4 |  | 1.3 | ns |
| $t_{\text {LABCARRY }}$ |  | 0.4 |  | 0.8 | ns |
| $t_{\text {LOCAL }}$ |  | 0.8 |  | 1.5 | ns |
| $t_{\text {ROW }}$ |  | 4.2 |  | 6.3 | ns |
| $t_{C O L}$ |  | 2.5 |  | 3.8 | ns |
| $t_{\text {DIN } C}$ |  | 5.5 |  | 8.0 | ns |
| $t_{\text {DIN } D}$ |  | 7.2 |  | 10.8 | ns |
| $t_{\text {DIN } 1 O}$ |  | 5.5 |  | 9.0 | ns |

## EPF8282AV Logic Element Timing Parameters

| Symbol | A-3 Speed Grade |  | A-4 Speed Grade |  | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: |
|  | Min | Max | Min | Max |  |
| $t_{\text {LUT }}$ |  | 3.2 |  | 7.3 | ns |
| $t_{\text {CLUT }}$ |  | 0.0 |  | 1.4 | ns |
| $t_{\text {RLUT }}$ |  | 1.5 |  | 5.1 | ns |
| $t_{\text {GATE }}$ |  | 0.0 |  | 0.0 | ns |
| $t_{\text {CASC }}$ |  | 0.9 |  | 2.8 | ns |
| $t_{C I C O}$ |  | 0.6 |  | 1.5 | ns |
| $t_{C G E N}$ |  | 0.7 |  | 2.2 | ns |
| $t_{C G E N R}$ |  | 1.5 |  | 3.7 | ns |
| $t_{C}$ |  | 2.5 |  | 4.7 | ns |
| $t_{C H}$ | 4.0 |  | 6.0 |  | ns |
| $t_{C L}$ | 4.0 |  | 6.0 |  | ns |
| $t_{C O}$ |  | 0.6 |  | 0.9 | ns |
| $t_{C O M B}$ |  | 0.6 |  | 0.9 | ns |
| $t_{\text {SU }}$ | 1.2 |  | 2.4 |  | ns |
| $t_{H}$ | 1.5 |  | 4.6 |  | ns |
| $t_{\text {PRE }}$ |  | 0.8 |  | 1.3 | ns |
| $t_{C L R}$ |  | 0.8 |  | 1.3 | ns |

EPF8282AV External Timing Parameters

| Symbol | A-3 Speed Grade |  | A-4 Speed Grade |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Max | Min | Max |  |
| t DRR |  | 24.8 |  | 50.1 | ns |
| $\mathbf{t}_{\text {ODH }}$ | 1.0 |  | 1.0 |  | ns |

## EPF8452A Internal Timing Parameters

EPF8452A I/O Element Timing Parameters

| Symbol | A-2 Speed Grade |  | A-3 Speed Grade |  | A-4 Speed Grade |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Max | Min | Max | Min | Max |  |
| $t_{I O D}$ |  | 0.7 |  | 0.8 |  | 0.9 | ns |
| $t_{I O C}$ |  | 1.7 |  | 1.8 |  | 1.9 | ns |
| $t_{I O E}$ |  | 1.7 |  | 1.8 |  | 1.9 | ns |
| $t_{\text {IOCO }}$ |  | 1.0 |  | 1.0 |  | 1.0 | ns |
| $t_{\text {IOCOMB }}$ |  | 0.3 |  | 0.2 |  | 0.1 | ns |
| tıosu | 1.4 |  | 1.6 |  | 1.8 |  | ns |
| $t_{\text {IOH }}$ | 0.0 |  | 0.0 |  | 0.0 |  | ns |
| $t_{\text {IOCLR }}$ |  | 1.2 |  | 1.2 |  | 1.2 | ns |
| $t_{\text {IN }}$ |  | 1.5 |  | 1.6 |  | 1.7 | ns |
| $t_{O D 1}$ |  | 1.1 |  | 1.4 |  | 1.7 | ns |
| $t_{O D 2}$ |  | - |  | - |  | - | ns |
| $t_{O D 3}$ |  | 4.6 |  | 4.9 |  | 5.2 | ns |
| $t_{X Z}$ |  | 1.4 |  | 1.6 |  | 1.8 | ns |
| $t_{Z X 1}$ |  | 1.4 |  | 1.6 |  | 1.8 | ns |
| $t_{Z X 2}$ |  | - |  | - |  | - | ns |
| $t_{Z X 3}$ |  | 4.9 |  | 5.1 |  | 5.3 | ns |

EPF8452A Interconnect Timing Parameters

| Symbol | A-2 Speed Grade |  | A-3 Speed Grade |  | A-4 Speed Grade |  | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Max | Min | Max | Min | Max |  |
| $t_{\text {LABCASC }}$ |  | 0.3 |  | 0.4 |  | 0.4 | ns |
| $t_{\text {LABCARRY }}$ |  | 0.3 |  | 0.4 |  | 0.4 | ns |
| $t_{\text {LOCAL }}$ |  | 0.5 |  | 0.5 |  | 0.7 | ns |
| $t_{\text {ROW }}$ |  | 5.0 |  | 5.0 |  | 5.0 | ns |
| $t_{C O L}$ |  | 3.0 |  | 3.0 |  | 3.0 | ns |
| $t_{\text {DIN_C }}$ |  | 5.0 |  | 5.0 |  | 5.5 | ns |
| $t_{\text {DIN_D }}$ |  | 7.0 |  | 7.0 |  | 7.5 | ns |
| $t_{\text {DIN_IO }}$ |  | 5.0 |  | 5.0 |  | 5.5 | ns |

## EPF8452A LE Timing Parameters

| Symbol | A-2 Speed Grade |  | A-3 Speed Grade |  | A-4 Speed Grade |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Max | Min | Max | Min | Max |  |
| $t_{\text {LUT }}$ |  | 2.0 |  | 2.3 |  | 3.0 | ns |
| $t_{\text {CLUT }}$ |  | 0.0 |  | 0.2 |  | 0.1 | ns |
| $t_{\text {RLUT }}$ |  | 0.9 |  | 1.6 |  | 1.6 | ns |
| $t_{\text {GATE }}$ |  | 0.0 |  | 0.0 |  | 0.0 | ns |
| $t_{\text {CASC }}$ |  | 0.6 |  | 0.7 |  | 0.9 | ns |
| $t_{\text {CICO }}$ |  | 0.4 |  | 0.5 |  | 0.6 | ns |
| $t_{\text {CGEN }}$ |  | 0.4 |  | 0.9 |  | 0.8 | ns |
| $t_{\text {CGENR }}$ |  | 0.9 |  | 1.4 |  | 1.5 | ns |
| $t_{C}$ |  | 1.6 |  | 1.8 |  | 2.4 | ns |
| $t_{\text {CH }}$ | 4.0 |  | 4.0 |  | 4.0 |  | ns |
| $t_{C L}$ | 4.0 |  | 4.0 |  | 4.0 |  | ns |
| $t_{\mathrm{CO}}$ |  | 0.4 |  | 0.5 |  | 0.6 | ns |
| ${ }^{t_{\text {COMB }}}$ |  | 0.4 |  | 0.5 |  | 0.6 | ns |
| $t_{S U}$ | 0.8 |  | 1.0 |  | 1.1 |  | ns |
| $t_{H}$ | 0.9 |  | 1.1 |  | 1.4 |  | ns |
| $t_{\text {PRE }}$ |  | 0.6 |  | 0.7 |  | 0.8 | ns |
| $t_{C L R}$ |  | 0.6 |  | 0.7 |  | 0.8 | ns |

EPF8452A External Timing Parameters

| Symbol | A-2 Speed Grade |  | A-3 Speed Grade |  | A-4 Speed Grade |  | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Max | Min | Max | Min | Max |  |
| $\boldsymbol{t}_{\text {DRR }}$ |  | 16.0 |  | 20.0 |  | 25.0 | ns |
| $\boldsymbol{t}_{\text {ODH }}$ | 1.0 |  | 1.0 |  | 1.0 |  | ns |

EPF8636A Internal Timing Parameters
EPF8636A I/O Element Timing Parameters

| Symbol | A-2 Speed Grade |  | A-3 Speed Grade |  | A-4 Speed Grade |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Max | Min | Max | Min | Max |  |
| $t_{I O D}$ |  | 0.7 |  | 0.8 |  | 0.9 | ns |
| $t_{10 C}$ |  | 1.7 |  | 1.8 |  | 1.9 | ns |
| $t_{I O E}$ |  | 1.7 |  | 1.8 |  | 1.9 | ns |
| $t_{\text {IOCO }}$ |  | 1.0 |  | 1.0 |  | 1.0 | ns |
| $t_{\text {IOCOMB }}$ |  | 0.3 |  | 0.2 |  | 0.1 | ns |
| tiosu | 1.4 |  | 1.6 |  | 1.8 |  | ns |
| $t_{\text {IOH }}$ | 0.0 |  | 0.0 |  | 0.0 |  | ns |
| $t_{\text {IOCLR }}$ |  | 1.2 |  | 1.2 |  | 1.2 | ns |
| $t_{\text {IN }}$ |  | 1.5 |  | 1.6 |  | 1.7 | ns |
| $t_{O D 1}$ |  | 1.1 |  | 1.4 |  | 1.7 | ns |
| $t_{\text {OD2 }}$ |  | 1.6 |  | 1.9 |  | 2.2 | ns |
| $t_{\text {OD3 }}$ |  | 4.6 |  | 4.9 |  | 5.2 | ns |
| $t_{X Z}$ |  | 1.4 |  | 1.6 |  | 1.8 | ns |
| $t_{Z X 1}$ |  | 1.4 |  | 1.6 |  | 1.8 | ns |
| $t_{Z X 2}$ |  | 1.9 |  | 2.1 |  | 2.3 | ns |
| $t_{Z X 3}$ |  | 4.9 |  | 5.1 |  | 5.3 | ns |

EPF8636A Interconnect Timing Parameters

| S Symbol | A-2 Speed Grade |  | A-3 Speed Grade |  | A-4 Speed Grade |  | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Max | Min | Max | Min | Max |  |
| $t_{\text {LABCASC }}$ |  | 0.3 |  | 0.4 |  | 0.4 | ns |
| $t_{\text {LABCARRY }}$ |  | 0.3 |  | 0.4 |  | 0.4 | ns |
| $t_{\text {LOCAL }}$ |  | 0.5 |  | 0.5 |  | 0.7 | ns |
| $t_{\text {ROW }}$ |  | 5.0 |  | 5.0 |  | 5.0 | ns |
| $t_{C O L}$ |  | 3.0 |  | 3.0 |  | 3.0 | ns |
| $t_{\text {DIN } C}$ |  | 5.0 |  | 5.0 |  | 5.5 | ns |
| $t_{\text {DIN } D}$ |  | 7.0 |  | 7.0 |  | 7.5 | ns |
| $t_{D I N I O}$ |  | 5.0 |  | 5.0 |  | 5.5 | ns |

EPF8636A LE Timing Parameters

| Symbol | A-2 Speed Grade |  | A-3 Speed Grade |  | A-4 Speed Grade |  | Unit |  |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Max | Min | Max | Min | Max |  |  |
| $t_{\text {LUT }}$ |  | 2.0 |  | 2.3 |  | 3.0 | ns |  |
| $t_{C L U T}$ |  | 0.0 |  | 0.2 |  | 0.1 | ns |  |
| $t_{\text {RLUT }}$ |  | 0.9 |  | 1.6 |  | 1.6 | ns |  |
| $t_{\text {GATE }}$ |  | 0.0 |  | 0.0 |  | 0.0 | ns |  |
| $t_{C A S C}$ |  | 0.6 |  | 0.7 |  | 0.9 | ns |  |
| $t_{C I C O}$ |  | 0.4 |  | 0.5 |  | 0.6 | ns |  |
| $t_{C G E N}$ |  | 0.4 |  | 0.9 |  | 0.8 | ns |  |
| $t_{C G E N R}$ |  | 0.9 |  | 1.4 |  | 1.5 | ns |  |
| $t_{C}$ |  | 1.6 |  | 1.8 |  | 2.4 | ns |  |
| $t_{C H}$ | 4.0 |  | 4.0 |  | 4.0 |  | ns |  |
| $t_{C L}$ | 4.0 |  | 4.0 |  | 4.0 |  | ns |  |
| $t_{C O}$ |  | 0.4 |  | 0.5 |  | 0.6 | ns |  |
| $t_{C O M B}$ |  | 0.4 |  | 0.5 |  | 0.6 | ns |  |
| $t_{\text {SU }}$ |  |  | 1.0 |  | 1.1 |  | ns |  |
| $t_{H}$ | 0.8 |  | 1.1 |  | 1.4 |  | ns |  |
| $t_{\text {PRE }}$ |  |  |  |  | 0.7 |  | 0.8 | ns |
| $t_{C L R}$ |  |  |  |  | 0.7 |  | 0.8 | ns |

EPF8636A External Timing Parameters

| Symbol | A-2 Speed Grade |  | A-3 Speed Grade |  | A-4 Speed Grade |  | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Max | Min | Max | Min | Max |  |
| $\boldsymbol{t}_{\text {DRR }}$ |  | 16.0 |  | 20.0 |  | 25.0 | ns |
| $\boldsymbol{t}_{\text {ODH }}$ | 1.0 |  | 1.0 |  | 1.0 |  | ns |

## EPF8820A Internal Timing Parameters

EPF8820A I/O Element Timing Parameters

| Symbol | A-2 Speed Grade |  | A-3 Speed Grade |  | A-4 Speed Grade |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Max | Min | Max | Min | Max |  |
| $t_{I O D}$ |  | 0.7 |  | 0.8 |  | 0.9 | ns |
| $t_{\text {IOC }}$ |  | 1.7 |  | 1.8 |  | 1.9 | ns |
| $t_{\text {IOE }}$ |  | 1.7 |  | 1.8 |  | 1.9 | ns |
| $t_{\text {IOCO }}$ |  | 1.0 |  | 1.0 |  | 1.0 | ns |
| $t_{\text {IOCOMB }}$ |  | 0.3 |  | 0.2 |  | 0.1 | ns |
| tiosu | 1.4 |  | 1.6 |  | 1.8 |  | ns |
| $t_{\text {IOH }}$ | 0.0 |  | 0.0 |  | 0.0 |  | ns |
| $t_{\text {IOCLR }}$ |  | 1.2 |  | 1.2 |  | 1.2 | ns |
| $t_{\text {IN }}$ |  | 1.5 |  | 1.6 |  | 1.7 | ns |
| $t_{O D 1}$ |  | 1.1 |  | 1.4 |  | 1.7 | ns |
| $t_{O D 2}$ |  | 1.6 |  | 1.9 |  | 2.2 | ns |
| $t_{\text {OD3 }}$ |  | 4.6 |  | 4.9 |  | 5.2 | ns |
| $t_{X Z}$ |  | 1.4 |  | 1.6 |  | 1.8 | ns |
| $t_{Z X 1}$ |  | 1.4 |  | 1.6 |  | 1.8 | ns |
| $t_{Z X 2}$ |  | 1.9 |  | 2.1 |  | 2.3 | ns |
| $t_{Z X 3}$ |  | 4.9 |  | 5.1 |  | 5.3 | ns |

## EPF8820A Interconnect Timing Parameters

| Symbol | A-2 Speed Grade |  | A-3 Speed Grade |  | A-4 Speed Grade |  | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Max | Min | Max | Min | Max |  |
| $t_{\text {LABCASC }}$ |  | 0.3 |  | 0.3 |  | 0.4 | ns |
| $t_{\text {LABCARRY }}$ |  | 0.3 |  | 0.3 |  | 0.4 | ns |
| $t_{\text {LOCAL }}$ |  | 0.5 |  | 0.6 |  | 0.8 | ns |
| $t_{\text {ROW }}$ |  | 5.0 |  | 5.0 |  | 5.0 | ns |
| $t_{C O L}$ |  | 3.0 |  | 3.0 |  | 3.0 | ns |
| $t_{\text {DIN_C }}$ |  | 5.0 |  | 5.0 |  | 5.5 | ns |
| $t_{\text {DIN_D }}$ |  | 7.0 |  | 7.0 |  | 7.5 | ns |
| $t_{\text {DIN_IO }}$ |  | 5.0 |  | 5.0 |  | 5.5 | ns |

## EPF8820A LE Timing Parameters

| Symbol | A-2 Speed Grade |  | A-3 Speed Grade |  | A-4 Speed Grade |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Max | Min | Max | Min | Max |  |
| $t_{\text {LUT }}$ |  | 2.0 |  | 2.5 |  | 3.2 | ns |
| $t_{\text {CLUT }}$ |  | 0.0 |  | 0.0 |  | 0.0 | ns |
| $t_{\text {RLUT }}$ |  | 0.9 |  | 1.1 |  | 1.5 | ns |
| $t_{\text {GATE }}$ |  | 0.0 |  | 0.0 |  | 0.0 | ns |
| $t_{\text {CASC }}$ |  | 0.6 |  | 0.7 |  | 0.9 | ns |
| $t_{\text {CICO }}$ |  | 0.4 |  | 0.5 |  | 0.6 | ns |
| $t_{\text {CGEN }}$ |  | 0.4 |  | 0.5 |  | 0.7 | ns |
| $t_{\text {CGENR }}$ |  | 0.9 |  | 1.1 |  | 1.5 | ns |
| $t_{C}$ |  | 1.6 |  | 2.0 |  | 2.5 | ns |
| $t_{\text {CH }}$ | 4.0 |  | 4.0 |  | 4.0 |  | ns |
| $t_{C L}$ | 4.0 |  | 4.0 |  | 4.0 |  | ns |
| $t_{C O}$ |  | 0.4 |  | 0.5 |  | 0.6 | ns |
| $t_{\text {COMB }}$ |  | 0.4 |  | 0.5 |  | 0.6 | ns |
| $t_{S U}$ | 0.8 |  | 1.1 |  | 1.2 |  | ns |
| $t_{H}$ | 0.9 |  | 1.1 |  | 1.5 |  | ns |
| $t_{\text {PRE }}$ |  | 0.6 |  | 0.7 |  | 0.8 | ns |
| $t_{C L R}$ |  | 0.6 |  | 0.7 |  | 0.8 | ns |

## EPF8820A External Timing Parameters

| Symbol | A-2 Speed Grade |  | A-3 Speed Grade |  | A-4 Speed Grade |  | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Max | Min | Max | Min | $\boldsymbol{M a x}$ |  |
| $\boldsymbol{t}_{\text {DRR }}$ |  | 16.0 |  | 20.0 |  | 25.0 | ns |
| $\mathbf{t}_{\text {ODH }}$ | 1.0 |  | 1.0 |  | 1.0 |  | ns |

## EPF81188A Internal Timing Parameters

EPF81188A I/O Element Timing Parameters

| Symbol | A-2 Speed Grade |  | A-3 Speed Grade |  | A-4 Speed Grade |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Max | Min | Max | Min | Max |  |
| $t_{I O D}$ |  | 0.7 |  | 0.8 |  | 0.9 | ns |
| $t_{\text {IOC }}$ |  | 1.7 |  | 1.8 |  | 1.9 | ns |
| $t_{\text {IOE }}$ |  | 1.7 |  | 1.8 |  | 1.9 | ns |
| $t_{\text {IOCO }}$ |  | 1.0 |  | 1.0 |  | 1.0 | ns |
| $t_{\text {IOCOMB }}$ |  | 0.3 |  | 0.2 |  | 0.1 | ns |
| $t_{\text {IOSU }}$ | 1.4 |  | 1.6 |  | 1.8 |  | ns |
| $t_{\text {IOH }}$ | 0.0 |  | 0.0 |  | 0.0 |  | ns |
| $t_{\text {IOCLR }}$ |  | 1.2 |  | 1.2 |  | 1.2 | ns |
| $t_{\text {IN }}$ |  | 1.5 |  | 1.6 |  | 1.7 | ns |
| $t_{O D 1}$ |  | 1.1 |  | 1.4 |  | 1.7 | ns |
| $t_{O D 2}$ |  | 1.6 |  | 1.9 |  | 2.2 | ns |
| $t_{\text {OD3 }}$ |  | 4.6 |  | 4.9 |  | 5.2 | ns |
| $t_{X Z}$ |  | 1.4 |  | 1.6 |  | 1.8 | ns |
| $t_{Z X 1}$ |  | 1.4 |  | 1.6 |  | 1.8 | ns |
| $t_{Z X 2}$ |  | 1.9 |  | 2.1 |  | 2.3 | ns |
| $t_{Z X 3}$ |  | 4.9 |  | 5.1 |  | 5.3 | ns |

EPF81188A Interconnect Timing Parameters

| Symbol | A-2 Speed Grade |  | A-3 Speed Grade |  | A-4 Speed Grade |  | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Max | Min | Max | Min | Max |  |
| $t_{\text {LABCASC }}$ |  | 0.3 |  | 0.3 |  | 0.4 | ns |
| $t_{\text {LABCARRY }}$ |  | 0.3 |  | 0.3 |  | 0.4 | ns |
| $t_{\text {LOCAL }}$ |  | 0.5 |  | 0.6 |  | 0.8 | ns |
| $t_{\text {ROW }}$ |  | 5.0 |  | 5.0 |  | 5.0 | ns |
| $t_{C O L}$ |  | 3.0 |  | 3.0 |  | 3.0 | ns |
| $t_{D I N C}$ |  | 5.0 |  | 5.0 |  | 5.5 | ns |
| $t_{\text {DIN } D}$ |  | 7.0 |  | 7.0 |  | 7.5 | ns |
| $t_{D I N \_I O}$ |  | 5.0 |  | 5.0 |  | 5.5 | ns |

EPF81188A LE Timing Parameters

| Symbol | A-2 Speed Grade |  | A-3 Speed Grade |  | A-4 Speed Grade |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Max | Min | Max | Min | Max |  |
| $t_{\text {LUT }}$ |  | 2.0 |  | 2.5 |  | 3.2 | ns |
| $t_{\text {CLUT }}$ |  | 0.0 |  | 0.0 |  | 0.0 | ns |
| $t_{\text {RLUT }}$ |  | 0.9 |  | 1.1 |  | 1.5 | ns |
| $t_{\text {GATE }}$ |  | 0.0 |  | 0.0 |  | 0.0 | ns |
| $t_{\text {CASC }}$ |  | 0.6 |  | 0.7 |  | 0.9 | ns |
| $t_{\text {CICO }}$ |  | 0.4 |  | 0.5 |  | 0.6 | ns |
| $t_{\text {CGEN }}$ |  | 0.4 |  | 0.5 |  | 0.7 | ns |
| $t_{\text {CGENR }}$ |  | 0.9 |  | 1.1 |  | 1.5 | ns |
| $t_{C}$ |  | 1.6 |  | 2.0 |  | 2.5 | ns |
| $t_{C H}$ | 4.0 |  | 4.0 |  | 4.0 |  | ns |
| $t_{C L}$ | 4.0 |  | 4.0 |  | 4.0 |  | ns |
| $t_{C O}$ |  | 0.4 |  | 0.5 |  | 0.6 | ns |
| $t_{\text {COMB }}$ |  | 0.4 |  | 0.5 |  | 0.6 | ns |
| $t_{S U}$ | 0.8 |  | 1.1 |  | 1.2 |  | ns |
| $t_{H}$ | 0.9 |  | 1.1 |  | 1.5 |  | ns |
| $t_{\text {PRE }}$ |  | 0.6 |  | 0.7 |  | 0.8 | ns |
| $t_{C L R}$ |  | 0.6 |  | 0.7 |  | 0.8 | ns |

EPF81188A External Timing Parameters

| Symbol | A-2 Speed Grade |  | A-3 Speed Grade |  | A-4 Speed Grade |  | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Max | Min | Max | Min | Max |  |
| $\boldsymbol{t}_{\text {DRR }}$ |  | 16.0 |  | 20.0 |  | 25.0 | ns |
| $\boldsymbol{t}_{\text {ODH }}$ | 1.0 |  | 1.0 |  | 1.0 |  | ns |

## EPF81500A Internal Timing Parameters

EPF81500A I/O Element Timing Parameters

| Symbol | A-2 Speed Grade |  | A-3 Speed Grade |  | A-4 Speed Grade |  | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Max | Min | Max | Min | Max |  |
| $t_{I O D}$ |  | 0.7 |  | 0.8 |  | 0.9 | ns |
| $t_{I O C}$ |  | 1.7 |  | 1.8 |  | 1.9 | ns |
| $t_{I O E}$ |  | 1.7 |  | 1.8 |  | 1.9 | ns |
| $t_{I O C O}$ |  | 1.0 |  | 1.0 |  | 1.0 | ns |
| $t_{I O C O M B}$ |  | 0.3 |  | 0.2 |  | 0.1 | ns |
| $t_{I O S U}$ | 1.4 |  | 1.6 |  | 1.8 |  | ns |
| $t_{I O H}$ | 0.0 |  | 0.0 |  | 0.0 |  | ns |
| $t_{I O C L R}$ |  | 1.2 |  | 1.2 |  | 1.2 | ns |
| $t_{I N}$ |  | 1.5 |  | 1.6 |  | 1.7 | ns |
| $t_{O D 1}$ |  | 1.1 |  | 1.4 |  | 1.7 | ns |
| $t_{O D 2}$ |  | 4.6 |  | 1.9 |  | 2.2 | ns |
| $t_{O D 3}$ |  | 1.4 |  | 4.9 |  | 5.2 | ns |
| $t_{X Z}$ |  | 1.4 |  | 1.6 |  | 1.8 | ns |
| $t_{Z X 1}$ |  | 1.9 |  | 1.6 |  | 1.8 | ns |
| $t_{Z X 2}$ |  | 4.9 |  | 2.1 |  | 2.3 | ns |
| $t_{Z X 3}$ |  |  | 5.1 |  | 5.3 | ns |  |

## EPF81500A Interconnect Timing Parameters

| Symbol | A-2 Speed Grade |  | A-3 Speed Grade |  | A-4 Speed Grade |  | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Max | Min | Max | Min | Max |  |
| $t_{\text {LABCASC }}$ |  | 0.3 |  | 0.3 |  | 0.4 | ns |
| $t_{\text {LABCARRY }}$ |  | 0.3 |  | 0.3 |  | 0.4 | ns |
| $t_{\text {LOCAL }}$ |  | 0.5 |  | 0.6 |  | 0.8 | ns |
| $t_{\text {ROW }}$ |  | 6.2 |  | 6.2 |  | 6.2 | ns |
| $t_{C O L}$ |  | 3.0 |  | 3.0 |  | 3.0 | ns |
| $t_{D I N \_C}$ |  | 5.0 |  | 5.0 |  | 5.5 | ns |
| $t_{D I N \_D}$ |  | 8.2 |  | 8.2 |  | 8.7 | ns |
| $t_{D I N \_I O}$ |  | 5.0 |  | 5.0 |  | 5.5 | ns |

EPF81500A LE Timing Parameters

| Symbol | A-2 Speed Grade |  | A-3 Speed Grade |  | A-4 Speed Grade |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Max | Min | Max | Min | Max |  |
| $t_{\text {LUT }}$ |  | 2.0 |  | 2.5 |  | 3.2 | ns |
| $t_{\text {CLUT }}$ |  | 0.0 |  | 0.0 |  | 0.0 | ns |
| $t_{\text {RLUT }}$ |  | 0.9 |  | 1.1 |  | 1.5 | ns |
| $t_{\text {GATE }}$ |  | 0.0 |  | 0.0 |  | 0.0 | ns |
| $t_{\text {CASC }}$ |  | 0.6 |  | 0.7 |  | 0.9 | ns |
| $t_{\text {CICO }}$ |  | 0.4 |  | 0.5 |  | 0.6 | ns |
| $t_{\text {CGEN }}$ |  | 0.4 |  | 0.5 |  | 0.7 | ns |
| $t_{\text {CGENR }}$ |  | 0.9 |  | 1.1 |  | 1.5 | ns |
| $t_{C}$ |  | 1.6 |  | 2.0 |  | 2.5 | ns |
| $t_{\text {CH }}$ | 4.0 |  | 4.0 |  | 4.0 |  | ns |
| $t_{C L}$ | 4.0 |  | 4.0 |  | 4.0 |  | ns |
| $t_{\text {CO }}$ |  | 0.4 |  | 0.5 |  | 0.6 | ns |
| $t_{\text {COMB }}$ |  | 0.4 |  | 0.5 |  | 0.6 | ns |
| $t_{S U}$ | 0.8 |  | 1.1 |  | 1.2 |  | ns |
| $t_{H}$ | 0.9 |  | 1.1 |  | 1.5 |  | ns |
| $t_{\text {PRE }}$ |  | 0.6 |  | 0.7 |  | 0.8 | ns |
| $t_{C L R}$ |  | 0.6 |  | 0.7 |  | 0.8 | ns |

EPF81500A External Timing Parameters

| Symbol | A-2 Speed Grade |  | A-3 Speed Grade |  | A-4 Speed Grade |  | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Max | Min | $\operatorname{Max}$ | $\boldsymbol{M i n}$ | $\boldsymbol{M a x}$ |  |
| $\mathbf{t}_{\text {DRR }}$ |  | 16.1 |  | 20.1 |  | 25.1 | ns |
| $\mathbf{t}_{\text {ODH }}$ | 1.0 |  | 1.0 |  | 1.0 |  | ns |

## Power Consumption

The supply power for FLEX 8000 devices, P , can be calculated with the following equation:
$\mathrm{P}=\mathrm{P}_{\mathrm{INT}}+\mathrm{P}_{\mathrm{IO}}=\left[\left(\mathrm{I}_{\mathrm{CCSTANDBY}}+\mathrm{I}_{\mathrm{CCACTIVE}}\right) \times \mathrm{V}_{\mathrm{CC}}\right]+\mathrm{P}_{\mathrm{IO}}$
Typical $\mathrm{I}_{\text {CCStandby }}$ values are shown as $\mathrm{I}_{\mathrm{CC} 0}$ in the "FLEX $80005.0-\mathrm{V}$ Device DC Operating Conditions" table on page 28 and the "FLEX 8000 3.3-V Device DC Operating Conditions" table on page 29. The $\mathrm{P}_{\mathrm{IO}}$ value, which depends on the device output load characteristics and switching frequency, can be calculated using the guidelines given in Application Note 74 (Evaluating Power for Altera Devices). The I ${ }_{\text {CCactive }}$ value depends on the switching frequency and the application logic. This value can be calculated based on the amount of current that each LE typically consumes.

The following equation shows the general formula for calculating ICCACTIVE:

$$
\mathrm{I}_{\mathrm{CCACTIVE}}=\mathrm{K} \times \mathbf{f}_{\mathbf{M A X}} \times \mathrm{N} \times \boldsymbol{\operatorname { t o g }}_{\mathbf{L C}} \times \frac{\mu \mathrm{A}}{\mathrm{MHz} \times \mathrm{LE}}
$$

The parameters in this equation are shown below:

```
f
N = Total number of logic cells used in the device
\boldsymbol{tog}
K = Constant, shown in Table 13
```

Table 13. Values for Constant $K$

| Device | K |
| :---: | :---: |
| 5.0-V FLEX 8000 devices | 75 |
| 3.3-V FLEX 8000 devices | 60 |

This calculation provides an $\mathrm{I}_{\mathrm{CC}}$ estimate based on typical conditions with no output load. The actual $\mathrm{I}_{\mathrm{CC}}$ value should be verified during operation because this measurement is sensitive to the actual pattern in the device and the environmental operating conditions.

Figure 20 shows the relationship between $\mathrm{I}_{\mathrm{CC}}$ and operating frequency for several LE utilization values.

Figure 20. FLEX $8000 I_{\text {CCactive }}$ vs. Operating Frequency
5.0-V FLEX 8000 Devices

3.3-V FLEX 8000 Devices


## Configuration \& Operation

The FLEX 8000 architecture supports several configuration schemes to load a design into the device(s) on the circuit board. This section summarizes the device operating modes and available device configuration schemes.

- For more information, go to Application Note 33 (Configuring FLEX 8000 Devices) and Application Note 38 (Configuring Multiple FLEX 8000 Devices).


## Operating Modes

The FLEX 8000 architecture uses SRAM elements that require configuration data to be loaded whenever the device powers up and begins operation. The process of physically loading the SRAM programming data into the device is called configuration. During initialization, which occurs immediately after configuration, the device resets registers, enables I/O pins, and begins to operate as a logic device. The I/O pins are tri-stated during power-up, and before and during configuration. The configuration and initialization processes together are called command mode; normal device operation is called user mode.

SRAM elements allow FLEX 8000 devices to be reconfigured in-circuit with new programming data that is loaded into the device. Real-time reconfiguration is performed by forcing the device into command mode with a device pin, loading different programming data, reinitializing the device, and resuming user-mode operation. The entire reconfiguration process requires less than 100 ms and can be used to dynamically reconfigure an entire system. In-field upgrades can be performed by distributing new configuration files.

## Configuration Schemes

The configuration data for a FLEX 8000 device can be loaded with one of six configuration schemes, chosen on the basis of the target application. Both active and passive schemes are available. In the active configuration schemes, the FLEX 8000 device functions as the controller, directing the loading operation, controlling external EPROM devices, and completing the loading process. The clock source for all active configuration schemes is an oscillator on the FLEX 8000 device that operates between 2 MHz and 6 MHz . In the passive configuration schemes, an external controller guides the FLEX 8000 device. Table 14 shows the data source for each of the six configuration schemes.

Table 14. Data Source for Configuration

| Configuration Scheme | Acronym | Data Source |
| :--- | :--- | :--- |
| Active serial | AS | Altera Configuration EPROM |
| Active parallel up | APU | Parallel EPROM |
| Active parallel down | APD | Parallel EPROM |
| Passive serial | PS | Serial data path |
| Passive parallel synchronous | PPS | Intelligent host |
| Passive parallel asynchronous | PPA | Intelligent host |

## Device Pin-Outs

Tables 15 through 17 show the pin names and numbers for the dedicated pins in each FLEX 8000 device package.

Table 15. FLEX 8000 84-, 100-, 144- \& 160-Pin Package Pin-Outs (Part 1 of 3)

| Pin Name | $\begin{gathered} \text { 84-Pin } \\ \text { PLCC } \\ \text { EPF8282A } \end{gathered}$ | 84-Pin <br> PLCC <br> EPF8452A <br> EPF8636A | 100-Pin TQFP EPF8282A EPF8282AV | $\begin{aligned} & \text { 100-Pin } \\ & \text { TQFP } \\ & \text { EPF8452A } \end{aligned}$ | 144-Pin TQFP EPF8820A | $\begin{gathered} \text { 160-Pin } \\ \text { PGA } \\ \text { EPF8452A } \end{gathered}$ | 160-Pin PQFP EPF8820A <br> Note (1) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| nSP (2) | 75 | 75 | 75 | 76 | 110 | R1 | 1 |
| MSEL0 (2) | 74 | 74 | 74 | 75 | 109 | P2 | 2 |
| MSEL1 (2) | 53 | 53 | 51 | 51 | 72 | A1 | 44 |
| nSTATUS (2) | 32 | 32 | 24 | 25 | 37 | C13 | 82 |
| nCONFIG (2) | 33 | 33 | 25 | 26 | 38 | A15 | 81 |
| DCLK (2) | 10 | 10 | 100 | 100 | 143 | P14 | 125 |
| CONF_DONE (2) | 11 | 11 | 1 | 1 | 144 | N13 | 124 |
| nWS | 30 | 30 | 22 | 23 | 33 | F13 | 87 |
| nRS | 48 | 48 | 42 | 45 | 31 | C6 | 89 |
| RDCLK | 49 | 49 | 45 | 46 | 12 | B5 | 110 |
| nCS | 29 | 29 | 21 | 22 | 4 | D15 | 118 |
| CS | 28 | 28 | 19 | 21 | 3 | E15 | 121 |
| RDYnBUSY | 77 | 77 | 77 | 78 | 20 | P3 | 100 |
| CLKUSR | 50 | 50 | 47 | 47 | 13 | C5 | 107 |
| ADD17 | 51 | 51 | 49 | 48 | 75 | B4 | 40 |
| ADD16 | 36 | 55 | 28 | 54 | 76 | E2 | 39 |
| ADD15 | 56 | 56 | 55 | 55 | 77 | D1 | 38 |
| ADD14 | 57 | 57 | 57 | 57 | 78 | E1 | 37 |
| ADD13 | 58 | 58 | 58 | 58 | 79 | F3 | 36 |
| ADD12 | 60 | 60 | 59 | 60 | 83 | F2 | 32 |
| ADD11 | 61 | 61 | 60 | 61 | 85 | F1 | 30 |
| ADD10 | 62 | 62 | 61 | 62 | 87 | G2 | 28 |
| ADD9 | 63 | 63 | 62 | 64 | 89 | G1 | 26 |
| ADD8 | 64 | 64 | 64 | 65 | 92 | H1 | 22 |
| ADD7 | 65 | 65 | 65 | 66 | 94 | H2 | 20 |
| ADD 6 | 66 | 66 | 66 | 67 | 95 | J1 | 18 |
| ADD5 | 67 | 67 | 67 | 68 | 97 | J2 | 16 |
| ADD 4 | 69 | 69 | 68 | 70 | 102 | K2 | 11 |
| ADD3 | 70 | 70 | 69 | 71 | 103 | K1 | 10 |
| ADD2 | 71 | 71 | 71 | 72 | 104 | K3 | 8 |
| ADD1 | 76 | 72 | 76 | 73 | 105 | M1 | 7 |

Table 15. FLEX 8000 84-, 100-, 144- \& 160-Pin Package Pin-Outs (Part 2 of 3)

| Pin Name | $\begin{gathered} \text { 84-Pin } \\ \text { PLCC } \\ \text { EPF8282A } \end{gathered}$ | 84-Pin PLCC EPF8452A EPF8636A | 100-Pin TQFP EPF8282A EPF8282AV | $\begin{aligned} & \text { 100-Pin } \\ & \text { TQFP } \\ & \text { EPF8452A } \end{aligned}$ | 144-Pin TQFP EPF8820A | $\begin{gathered} \text { 160-Pin } \\ \text { PGA } \\ \text { EPF8452A } \end{gathered}$ | 160-Pin PQFP EPF8820A Note (1) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ADD 0 | 78 | 76 | 78 | 77 | 106 | N3 | 6 |
| DATA7 | 3 | 2 | 90 | 89 | 131 | P8 | 140 |
| DATA6 | 4 | 4 | 91 | 91 | 132 | P10 | 139 |
| DATA5 | 6 | 6 | 92 | 95 | 133 | R12 | 138 |
| DATA4 | 7 | 7 | 95 | 96 | 134 | R13 | 136 |
| DATA3 | 8 | 8 | 97 | 97 | 135 | P13 | 135 |
| DATA2 | 9 | 9 | 99 | 98 | 137 | R14 | 133 |
| DATA1 | 13 | 13 | 4 | 4 | 138 | N15 | 132 |
| DATA0 | 14 | 14 | 5 | 5 | 140 | K13 | 129 |
| SDOUT (3) | 79 | 78 | 79 | 79 | 23 | P4 | 97 |
| TDI (4) | 55 | 45 (5) | 54 | - | 96 | - | 17 |
| TDO (4) | 27 | 27 (5) | 18 | - | 18 | - | 102 |
| TCK (4) | 72 | 44 (5) | 72 | - | 88 | - | 27 |
| TMS (4) | 20 | 43 (5) | 11 | - | 86 | - | 29 |
| TRST (6) | 52 | 52 (7) | 50 | - | 71 | - | 45 |
| Dedicated Inputs (8) | $\begin{aligned} & 12,31,54, \\ & 73 \end{aligned}$ | $\begin{aligned} & 12,31,54, \\ & 73 \end{aligned}$ | 3, 23, 53, 73 | $\begin{aligned} & 3,24,53, \\ & 74 \end{aligned}$ | $\begin{aligned} & 9,26,82, \\ & 99 \end{aligned}$ | $\begin{aligned} & \hline \text { C3, D14, } \\ & \text { N2, R15 } \end{aligned}$ | $\begin{aligned} & 14,33,94, \\ & 113 \end{aligned}$ |
| VCCINT | $\begin{aligned} & 17,38,59, \\ & 80 \end{aligned}$ | $\begin{aligned} & 17,38,59, \\ & 80 \end{aligned}$ | $\begin{aligned} & 6,20,37,56, \\ & 70,87 \end{aligned}$ | $\begin{aligned} & 9,32,49, \\ & 59,82 \end{aligned}$ | $\begin{aligned} & 8,28,70, \\ & 90,111 \end{aligned}$ | $\begin{aligned} & \text { B2, C4, D3, } \\ & \text { D8, D12, } \\ & \text { G3, G12, } \\ & \text { H4, H13, } \\ & \text { J3, J12, } \\ & \text { M4, M7, } \\ & \text { M9, M13, } \\ & \text { N12 } \end{aligned}$ | $\begin{aligned} & \hline 3,24,46, \\ & 92,114, \\ & 160 \end{aligned}$ |
| VCCIO | - | - | - | - | $\begin{aligned} & 16,40,60, \\ & 69,91, \\ & 112,122, \\ & 141 \end{aligned}$ | - | $\begin{aligned} & 23,47,57, \\ & 69,79, \\ & 104,127, \\ & 137,149, \\ & 159 \end{aligned}$ |

Table 15. FLEX 8000 84-, 100-, 144- \& 160-Pin Package Pin-Outs (Part 3 of 3)

| Pin Name | $\begin{gathered} \text { 84-Pin } \\ \text { PLCC } \\ \text { EPF8282A } \end{gathered}$ | $\begin{gathered} \text { 84-Pin } \\ \text { PLCC } \\ \text { EPF8452A } \\ \text { EPF8636A } \end{gathered}$ | $\begin{aligned} & \text { 100-Pin } \\ & \text { TQFP } \\ & \text { EPF8282A } \\ & \text { EPF8282AV } \end{aligned}$ | $\begin{aligned} & \text { 100-Pin } \\ & \text { TQFP } \\ & \text { EPF8452A } \end{aligned}$ | $\begin{aligned} & \text { 144-Pin } \\ & \text { TQFP } \\ & \text { EPF8820A } \end{aligned}$ | $\begin{gathered} \text { 160-Pin } \\ \text { PGA } \\ \text { EPF8452A } \end{gathered}$ | $\begin{gathered} \text { 160-Pin } \\ \text { PQFP } \\ \text { EPF8820A } \\ \text { Note (1) } \end{gathered}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| GND | 5, 26, 47, 68 | $\begin{aligned} & 5,26,47, \\ & 68 \end{aligned}$ | $\begin{aligned} & 2,13,30,44, \\ & 52,63,80, \\ & 94 \end{aligned}$ | $\begin{aligned} & 19,44,69, \\ & 94 \end{aligned}$ | $\begin{aligned} & 7,17,27, \\ & 39,54, \\ & 80,81, \\ & 100,101, \\ & 128,142 \end{aligned}$ | C12, D4, D7, D9, D13, G4, G13, H3, H12, J4, J13, L1, M3, M8, M12, M15, N4 | $\begin{aligned} & 12,13,34, \\ & 35,51,63, \\ & 75,80,83, \\ & 93,103, \\ & 115,126, \\ & 131,143, \\ & 155 \end{aligned}$ |
| No Connect (N.C.) | - | - | - | $\begin{aligned} & \hline 2,6,13,30, \\ & 37,42,43, \\ & 50,52,56, \\ & 63,80,87, \\ & 92,93,99 \end{aligned}$ | - | - | - |
| Total User I/O Pins | 64 | 64 | 74 | 64 | 108 | 116 | 116 |

Table 16. FLEX 8000 160-, 192- \& 208-Pin Package Pin-Outs (Part 1 of 2)

| Pin Name | $\begin{aligned} & \text { 160-Pin } \\ & \text { PQFP } \\ & \text { EPF8452A } \end{aligned}$ | $\begin{gathered} \text { 160-Pin } \\ \text { PQFP } \\ \text { EFP8636A } \end{gathered}$ | $\begin{gathered} \text { 192-Pin PGA } \\ \text { EPF8636A } \\ \text { EPF8820A } \end{gathered}$ | $\begin{array}{\|c} \text { 208-Pin } \\ \text { PQFP } \\ \text { EPF8636A } \end{array}$ | $\begin{array}{\|c\|} \hline \text { 208-Pin } \\ \text { PQFP } \\ \text { EPF8820A } \\ \hline \end{array}$ | $\qquad$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| nSP (2) | 120 | 1 | R15 | 207 | 207 | 5 |
| MSELO (2) | 117 | 3 | T15 | 4 | 4 | 21 |
| MSEL1 (2) | 84 | 38 | T3 | 49 | 49 | 33 |
| nSTATUS (2) | 37 | 83 | B3 | 108 | 108 | 124 |
| nCONFIG (2) | 40 | 81 | C3 | 103 | 103 | 107 |
| DCLK (2) | 1 | 120 | C15 | 158 | 158 | 154 |
| CONF_DONE <br> (2) | 4 | 118 | B15 | 153 | 153 | 138 |
| nWS | 30 | 89 | C5 | 114 | 114 | 118 |
| nRS | 71 | 50 | B5 | 66 | 116 | 121 |
| RDCLK | 73 | 48 | C11 | 64 | 137 | 137 |
| nCS | 29 | 91 | B13 | 116 | 145 | 142 |
| CS | 27 | 93 | A16 | 118 | 148 | 144 |
| RDYnBuSY | 125 | 155 | A8 | 201 | 127 | 128 |
| CLKUSR | 76 | 44 | A10 | 59 | 134 | 134 |
| ADD17 | 78 | 43 | R5 | 57 | 43 | 46 |
| ADD16 | 91 | 33 | U3 | 43 | 42 | 45 |
| ADD15 | 92 | 31 | T5 | 41 | 41 | 44 |
| ADD14 | 94 | 29 | U4 | 39 | 40 | 39 |
| ADD13 | 95 | 27 | R6 | 37 | 39 | 37 |
| ADD12 | 96 | 24 | T6 | 31 | 35 | 36 |
| ADD11 | 97 | 23 | R7 | 30 | 33 | 31 |
| ADD10 | 98 | 22 | T7 | 29 | 31 | 30 |
| ADD9 | 99 | 21 | T8 | 28 | 29 | 29 |
| ADD8 | 101 | 20 | U9 | 24 | 25 | 26 |
| ADD7 | 102 | 19 | U10 | 23 | 23 | 25 |
| ADD 6 | 103 | 18 | U11 | 22 | 21 | 24 |
| ADD5 | 104 | 17 | U12 | 21 | 19 | 18 |
| ADD 4 | 105 | 13 | R12 | 14 | 14 | 17 |
| ADD3 | 106 | 11 | U14 | 12 | 13 | 16 |
| ADD2 | 109 | 9 | U15 | 10 | 11 | 10 |
| ADD1 | 110 | 7 | R13 | 8 | 10 | 9 |
| ADD0 | 123 | 157 | U16 | 203 | 9 | 8 |
| DATA7 | 144 | 137 | H17 | 178 | 178 | 177 |
| DATA6 | 150 | 132 | G17 | 172 | 176 | 175 |

Table 16. FLEX 8000 160-, 192- \& 208-Pin Package Pin-Outs (Part 2 of 2)

| Pin Name | $\begin{gathered} \text { 160-Pin } \\ \text { PQFP } \\ \text { EPF8452A } \end{gathered}$ | $\begin{aligned} & \text { 160-Pin } \\ & \text { PQFP } \\ & \text { EFP8636A } \end{aligned}$ | $\begin{gathered} \text { 192-Pin PGA } \\ \text { EPF8636A } \\ \text { EPF8820A } \end{gathered}$ | $\begin{array}{\|c} \text { 208-Pin } \\ \text { PQFP } \\ \text { EPF8636A (1) } \\ \hline \end{array}$ | $\begin{array}{\|c} \text { 208-Pin } \\ \text { PQFP } \\ \text { EPF8820A (1) } \\ \hline \end{array}$ | $\qquad$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DATA5 | 152 | 129 | F17 | 169 | 174 | 172 |
| DATA4 | 154 | 127 | E17 | 165 | 172 | 170 |
| DATA3 | 157 | 124 | G15 | 162 | 171 | 168 |
| DATA2 | 159 | 122 | F15 | 160 | 167 | 166 |
| DATA1 | 11 | 115 | E16 | 149 | 165 | 163 |
| DATA0 | 12 | 113 | C16 | 147 | 162 | 161 |
| SDOUT (3) | 128 | 152 | C7 (9) | 198 | 124 | 119 |
| TDI (4) | - | 55 | R11 | 72 | 20 | - |
| TDO (4) | - | 95 | B9 | 120 | 129 | - |
| TCK (4) | - | 57 | U8 | 74 | 30 | - |
| TMS (4) | - | 59 | U7 | 76 | 32 | - |
| TRST (6) | - | 40 | R3 | 54 | 54 | - |
| Dedicated Inputs (8) | 5, 36, 85, 116 | 6, 35, 87, 116 | $\begin{aligned} & \text { A5, U5, U13, } \\ & \text { A13 } \end{aligned}$ | $\begin{aligned} & \hline 7,45,112, \\ & 150 \\ & \hline \end{aligned}$ | $\begin{aligned} & \hline 17,36,121, \\ & 140 \\ & \hline \end{aligned}$ | $\begin{array}{\|l\|} \hline 13,41,116, \\ 146 \\ \hline \end{array}$ |
| $\begin{aligned} & \text { VCCINT } \\ & (5.0 \mathrm{~V}) \end{aligned}$ | $\begin{aligned} & 21,41,53,67, \\ & 80,81,100,121, \\ & 133,147,160 \end{aligned}$ | $\begin{aligned} & 4,5,26,85, \\ & 106 \end{aligned}$ | $\begin{aligned} & \text { C8, C9, C10, } \\ & \text { R8, R9, R10, } \\ & \text { R14 } \end{aligned}$ | $\begin{aligned} & 5,6,33,110, \\ & 137 \end{aligned}$ | $\begin{aligned} & \hline 5,6,27,48, \\ & 119,141 \end{aligned}$ | $\begin{aligned} & 4,20,35,48, \\ & 50,102,114, \\ & 131,147 \end{aligned}$ |
|  | - | $\begin{aligned} & 25,41,60,70, \\ & 80,107,121, \\ & 140,149,160 \end{aligned}$ | $\begin{aligned} & \text { D3, D4, D9, } \\ & \text { D14, D15, G4, } \\ & \text { G14, L4, L14, } \\ & \text { P4, P9, P14 } \end{aligned}$ | $\begin{aligned} & \hline 32,55,78,91, \\ & 102,138,159, \\ & 182,193,206 \end{aligned}$ | $\begin{aligned} & \hline 26,55,69,87, \\ & 102,131,159, \\ & 173,191,206 \end{aligned}$ | $\begin{aligned} & 3,19,34,49, \\ & 69,87,106, \\ & 123,140,156, \\ & 174,192 \end{aligned}$ |
| GND | $\begin{aligned} & 13,14,28,46, \\ & 60,75,93,107, \\ & 108,126,140, \\ & 155 \end{aligned}$ | $\begin{aligned} & \hline 15,16,36,37, \\ & 45,51,75,84, \\ & 86,96,97, \\ & 117,126,131, \\ & 154 \end{aligned}$ | $\begin{aligned} & \mathrm{C} 4, \mathrm{D} 7, \mathrm{D} 8, \\ & \mathrm{D} 10, \mathrm{D} 11, \mathrm{H} 4, \\ & \mathrm{H} 14, \mathrm{~K} 4, \mathrm{~K} 14, \\ & \text { P7, P8, P10, } \\ & \text { P11 } \end{aligned}$ | $19,20,46,47$, $60,67,96$, $109,111,124$, $125,151,164$, 171,200 | 15, 16, 37, 38, $60,78,96$, $109,110,120$, $130,142,152$, $164,182,200$ | $11,12,27,28$, <br> $42,43,60,78$, <br> $96,105,115$, <br> $122,132,139$, <br> $148,155,159$, <br> $165,183,201$ |
| No Connect (N.C.) | $\begin{aligned} & 2,3,38,39,70, \\ & 82,83,118,119, \\ & 148 \end{aligned}$ | 2, 39, 82, 119 | $\begin{aligned} & \text { C6, C12, C13, } \\ & \text { C14, E3, E15, } \\ & \text { F3, J3, J4, } \\ & \text { J14, J15, N3, } \\ & \text { N15, P3, P15, } \\ & \text { R4 (10) } \end{aligned}$ | $1,2,3,16,17$, $18,25,26,27$, $34,35,36,50$, $51,52,53$, $104,105,106$, $107,121,122$, $123,130,131$, $132,139,140$, $141,154,155$, $156,157,208$ | $\begin{aligned} & 1,2,3,50,51, \\ & 52,53,104, \\ & 105,106,107, \\ & 154,155,156, \\ & 157,28 \end{aligned}$ | $\begin{aligned} & 1,2,51,52,53, \\ & 54,103,104, \\ & 157,158,207, \\ & 208 \end{aligned}$ |
| Total User I/O Pins | 116 | 114 | 132, 148 (11) | 132 | 148 | 144 |

Table 17. FLEX 8000 225-, 232-, 240-, 280- \& 304-Pin Package Pin-Outs (Part 1 of 3)

| Pin Name | $\begin{gathered} \text { 225-Pin } \\ \text { BGA } \\ \text { EPF8820A } \end{gathered}$ | $\begin{gathered} \text { 232-Pin } \\ \text { PGA } \\ \text { EPF81188A } \end{gathered}$ | $\begin{gathered} \text { 240-Pin } \\ \text { PQFP } \\ \text { EPF81188A } \end{gathered}$ | $\begin{gathered} 240-\text { Pin } \\ \text { PQFP } \\ \text { EPF81500A } \end{gathered}$ | $\begin{gathered} \text { 280-Pin } \\ \text { PGA } \\ \text { EPF81500A } \end{gathered}$ | $\begin{gathered} \text { 304-Pin } \\ \text { RQFP } \\ \text { EPF81500A } \\ \hline \end{gathered}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| nSP (2) | A15 | C14 | 237 | 237 | W1 | 304 |
| MSELO (2) | B14 | G15 | 21 | 19 | N1 | 26 |
| MSEL1 (2) | R15 | L15 | 40 | 38 | H3 | 51 |
| nSTATUS (2) | P2 | L3 | 141 | 142 | G19 | 178 |
| nCONFIG (2) | R1 | R4 | 117 | 120 | B18 | 152 |
| DCLK (2) | B2 | C4 | 184 | 183 | U18 | 230 |
| CONF_DONE (2) | A1 | G3 | 160 | 161 | M16 | 204 |
| nWS | L4 | P1 | 133 | 134 | F18 | 167 |
| nRS | K5 | N1 | 137 | 138 | G18 | 171 |
| RDCLK | F1 | G2 | 158 | 159 | M17 | 202 |
| nCS | D1 | E2 | 166 | 167 | N16 | 212 |
| CS | C1 | E3 | 169 | 170 | N18 | 215 |
| RDYnBUSY | J3 | K2 | 146 | 147 | J17 | 183 |
| CLKUSR | G2 | H2 | 155 | 156 | K19 | 199 |
| ADD17 | M14 | R15 | 58 | 56 | E3 | 73 |
| ADD16 | L12 | T17 | 56 | 54 | E2 | 71 |
| ADD15 | M15 | P15 | 54 | 52 | F4 | 69 |
| ADD14 | L13 | M14 | 47 | 45 | G1 | 60 |
| ADD13 | L14 | M15 | 45 | 43 | H2 | 58 |
| ADD12 | K13 | M16 | 43 | 41 | H1 | 56 |
| ADD11 | K15 | K15 | 36 | 34 | J3 | 47 |
| ADD10 | J13 | K17 | 34 | 32 | K3 | 45 |
| ADD9 | J15 | J14 | 32 | 30 | K4 | 43 |
| ADD8 | G14 | J15 | 29 | 27 | L1 | 34 |
| ADD7 | G13 | H17 | 27 | 25 | L2 | 32 |
| ADD 6 | G11 | H15 | 25 | 23 | M1 | 30 |
| ADD5 | F14 | F16 | 18 | 16 | N2 | 20 |
| ADD 4 | E13 | F15 | 16 | 14 | N3 | 18 |
| ADD3 | D15 | F14 | 14 | 12 | N4 | 16 |
| ADD2 | D14 | D15 | 7 | 5 | U1 | 8 |
| ADD1 | E12 | B17 | 5 | 3 | U2 | 6 |
| ADD0 | C15 | C15 | 3 | 1 | V1 | 4 |
| DATA7 | A7 | A7 | 205 | 199 | W13 | 254 |
| DATA6 | D7 | D8 | 203 | 197 | W14 | 252 |
| DATA5 | A6 | B7 | 200 | 196 | W15 | 250 |
| DATA4 | A5 | C7 | 198 | 194 | W16 | 248 |

Table 17. FLEX 8000 225-, 232-, 240-, 280- \& 304-Pin Package Pin-Outs (Part 2 of 3)

| Pin Name | $\begin{gathered} 225-P i n \\ \text { BGA } \\ \text { EPF8820A } \end{gathered}$ | $\begin{gathered} \text { 232-Pin } \\ \text { PGA } \\ \text { EPF81188A } \end{gathered}$ | $\begin{gathered} \text { 240-Pin } \\ \text { PQFP } \\ \text { EPF81188A } \end{gathered}$ | $\begin{gathered} \text { 240-Pin } \\ \text { PQFP } \\ \text { EPF81500A } \end{gathered}$ | $\begin{gathered} \text { 280-Pin } \\ \text { PGA } \\ \text { EPF81500A } \end{gathered}$ | $\begin{gathered} \text { 304-Pin } \\ \text { RQFP } \\ \text { EPF81500A } \end{gathered}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DATA3 | B5 | D7 | 196 | 193 | W17 | 246 |
| DATA2 | E6 | B5 | 194 | 190 | V16 | 243 |
| DATA1 | D5 | A3 | 191 | 189 | U16 | 241 |
| DATA0 | C4 | A2 | 189 | 187 | V17 | 239 |
| SDOUT (3) | K1 | N2 | 135 | 136 | F19 | 169 |
| TDI | F15 (4) | - | - | 63 (12) | B1 (12) | 80 (12) |
| TDO | J2 (4) | - | - | 117 (12) | C17 (12) | 149 (12) |
| TCK | J14 (4) | - | - | 116 (12) | A19 (12) | 148 (12) |
| TMS | J12 (4) | - | - | 64 (12) | C2 (12) | 81 (12) |
| TRST (6) | P14 | - | - | 115 | A18 | 145 |
| Dedicated Inputs <br> (8) | $\begin{aligned} & \text { F4, L1, K12, } \\ & \text { E15 } \end{aligned}$ | $\begin{aligned} & \text { C1, C17, R1, } \\ & \text { R17 } \end{aligned}$ | $\begin{aligned} & \hline 10,51,130, \\ & 171 \end{aligned}$ | $\begin{aligned} & 8,49,131, \\ & 172 \end{aligned}$ | $\begin{aligned} & \text { F1, F16, P3, } \\ & \text { P19 } \end{aligned}$ | $\begin{aligned} & \text { 12, 64, 164, } \\ & 217 \end{aligned}$ |
| $\begin{aligned} & \text { VCCINT } \\ & (5.0 \mathrm{~V}) \end{aligned}$ | $\begin{aligned} & \text { F5, F10, E1, } \\ & \text { L2, K4, M12, } \\ & \text { P15, H13, } \\ & \text { H14, B15, } \\ & \text { C13 } \end{aligned}$ | $\begin{aligned} & \text { E4, H4, L4, } \\ & \text { P12, L14, } \\ & \text { H14, E14, } \\ & \text { R14, U1 } \end{aligned}$ | $\begin{aligned} & 20,42,64,66, \\ & 114,128,150, \\ & 172,236 \end{aligned}$ | $18,40,60,62$, $91,114,129$, $151,173,209$, 236 | $\begin{aligned} & \text { B17, D3, D15, } \\ & \text { E8, E10, E12, } \\ & \text { E14, R7, R9, } \\ & \text { R11, R13, } \\ & \text { R14, T14 } \end{aligned}$ | $\begin{aligned} & \hline 24,54,77, \\ & 144,79,115, \\ & 162,191,218, \\ & 266,301 \end{aligned}$ |
| $\begin{aligned} & \text { VCCIO } \\ & (5.0 \mathrm{~V} \text { or } 3.3 \mathrm{~V} \text { ) } \end{aligned}$ | $\begin{array}{\|l} \hline \text { H3, H2, P6, } \\ \text { R6, P10, N10, } \\ \text { R14, N13, } \\ \text { H15, H12, } \\ \text { D12, A14, } \\ \text { B10, A10, B6, } \\ \text { C6, A2, C3, } \\ \text { M4, R2 } \end{array}$ | N10, M13, M5, K13, K5, H13, H5, F5, E10, E8, N8, F13 | $\begin{aligned} & \hline 19,41,65,81, \\ & 99,116,140, \\ & 162,186,202, \\ & 220,235 \end{aligned}$ | $17,39,61,78$, $94,108,130$, $152,174,191$ $205,221,235$ | $\begin{aligned} & \text { D14, E7, E9, } \\ & \text { E11, E13, R6, } \\ & \text { R8, R10, R12, } \\ & \text { T13, T15 } \end{aligned}$ | $\begin{aligned} & \hline 22,53,78,99, \\ & 119,137,163, \\ & 193,220,244, \\ & 262,282,300 \end{aligned}$ |
| GND | $\begin{aligned} & \text { B1, D4, E14, } \\ & \text { F7, F8, F9, } \\ & \text { F12, G6, G7, } \\ & \text { G8, G9, G10, } \\ & \text { H1, H4, H5, } \\ & \text { H6, H7, H8, } \\ & \text { H9, H10, H11, } \\ & \text { J6, J7, J8, J9, } \\ & \text { J10, K6, K7, } \\ & \text { K8, K9, K11, } \\ & \text { L15, N3, P1 } \end{aligned}$ | $\begin{aligned} & \hline \text { A1, D6, E11, } \\ & \text { E7, E9, G4, } \\ & \text { G5, G13, } \\ & \text { G14, J5, J13, } \\ & \text { K4, K14, L5, } \\ & \text { L13, N4, N7, } \\ & \text { N9, N11, N14 } \end{aligned}$ | $\begin{aligned} & \hline 8,9,30,31, \\ & 52,53,72,90, \\ & 108,115,129, \\ & 139,151,161, \\ & 173,185,187, \\ & 193,211,229 \end{aligned}$ | 6, 7, 28, 29, $50,51,71,85$, $92,101,118$, $119,140,141$, $162,163,184$, $185,186,198$, $208,214,228$ | D4, D5, D16, E4, E5, E6, E15, E16, F5, F15, G5, G15, H5, H15, J5, J15, K5, K15, L5, L15, M5, M15, N5, N15, P4, P5, P15, P16, R4, R5, R15, R16, T4, T5, T16, U17 | $9,11,36,38$, $65,67,90$, 108,116, 128,150, $151,175,177$, $206,208,231$, $232,237,253$, $265,273,291$ |

Table 17. FLEX 8000 225-, 232-, 240-, 280- \& 304-Pin Package Pin-Outs (Part 3 of 3)

| Pin Name | $\begin{gathered} \text { 225-Pin } \\ \text { BGA } \\ \text { EPF8820A } \end{gathered}$ | $\begin{gathered} \text { 232-Pin } \\ \text { PGA } \\ \text { EPF81188A } \end{gathered}$ | $\begin{gathered} \text { 240-Pin } \\ \text { PQFP } \\ \text { EPF81188A } \end{gathered}$ | $\begin{gathered} \text { 240-Pin } \\ \text { PQFP } \\ \text { EPF81500A } \end{gathered}$ | $\begin{gathered} \text { 280-Pin } \\ \text { PGA } \\ \text { EPF81500A } \end{gathered}$ | $\begin{gathered} \text { 304-Pin } \\ \text { RQFP } \\ \text { EPF81500A } \end{gathered}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| No Connect (N.C.) | - | - | $\begin{aligned} & 61,62,119, \\ & 120,181,182, \\ & 239,240 \end{aligned}$ | - | - | $\begin{aligned} & 10,21,23,25, \\ & 35,37,39,40, \\ & 41,42,52,55, \\ & 66,68,146, \\ & 147,161,173, \\ & 174,176,187, \\ & 188,189,190, \\ & 192,194,195, \\ & 205,207,219, \\ & 221,233,234, \\ & 235,236,302, \\ & 303 \end{aligned}$ |
| Total User I/O Pins | 148 | 180 | 180 | 177 | 204 | 204 |

Notes to tables:
(1) Perform a complete thermal analysis before committing a design to this device package. See Application Note 74 (Evaluating Power for Altera Devices) in this data book for more information.
(2) This pin is a dedicated pin and is not available as a user I/O pin.
(3) SDOUT will drive out during configuration. After configuration, it may be used as a user I/O pin. By default, the MAX+PLUS II software will not use SDOUT as a user I/O pin; the user can override the MAX + PLUS II software and use SDOUT as a user I/O pin.
(4) If the device is not configured to use the JTAG BST circuitry, this pin is available as a user I/O pin.
(5) JTAG pins are available for EPF8636A devices only. These pins are dedicated user I/O pins.
(6) TRST is a dedicated input pin for JTAG use. This pin must be grounded if JTAG BST is not used.
(7) Pin 52 is a $V_{C C}$ pin on EPF8452A devices only.
(8) Unused dedicated inputs should be tied to ground on the board.
(9) SDOUT does not exist in the EPF8636GC192 device.
(10) These pins are no connect (N.C.) pins for EPF8636A devices only. They are user I/O pins in EPF8820A devices.
(11) EPF8636A devices have 132 user I/O pins; EPF8820A devices have 148 user I/O pins.
(12) For EPF81500A devices, these pins are dedicated JTAG pins and are not available as user I/O pins. If JTAG BST is not used, TRST must be grounded. TMS, TDI, and TCK should be tied to $\mathrm{V}_{\mathrm{CC}}$.

## Revision History

The information contained in the FLEX 8000 Programmable Logic Device Family Data Sheet version 9.11 supersedes information published in previous versions.

## Version 9.11 Change

The FLEX 8000 Programmable Logic Device Family Data Sheet version 9.11 contains the following change: Figure 14 has been updated for accuracy.

## Version 9.10 Changes

The FLEX 8000 Programmable Logic Device Family Data Sheet version 9.10 contains the following changes:

Updated timing information for A-4 speed grade EPF8282AV devices.

- Added timing information for A-3 speed grade EPF8282AV devices.

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[^0]:    - Configuration EPROMs for FLEX Devices Data Sheet
    - BitBlaster Serial Download Cable Data Sheet
    - ByteBlaster Parallel Port Download Cable Data Sheet
    - Application Note 33 (Configuring FLEX 8000 Devices)
    - Application Note 38 (Configuring Multiple FLEX 8000 Devices)

